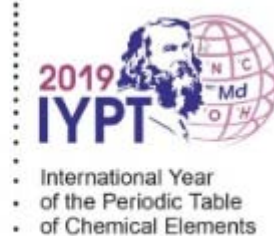


# Silicon, the key element for photovoltaic energy: past, present and future perspectives

Simona Binetti

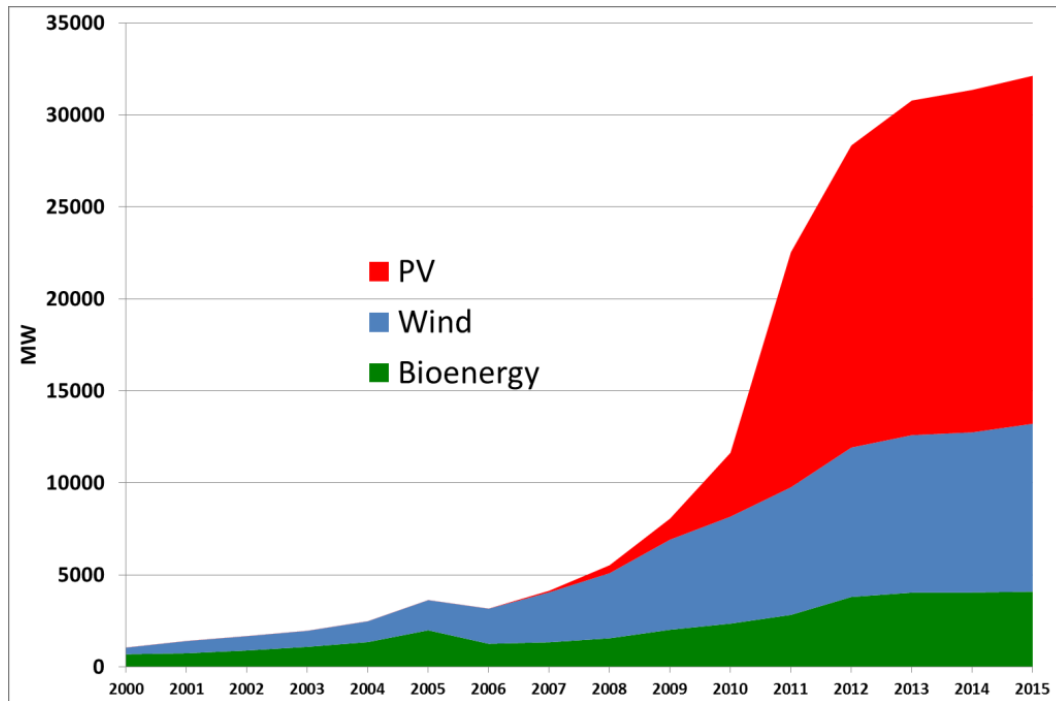
MIB-SOLAR center, Department of Material Science, University of Milano-Bicocca  
e-mail: [simona.binetti@unimib.it](mailto:simona.binetti@unimib.it)

*AVOGADRO COLLOQUIA 2019*

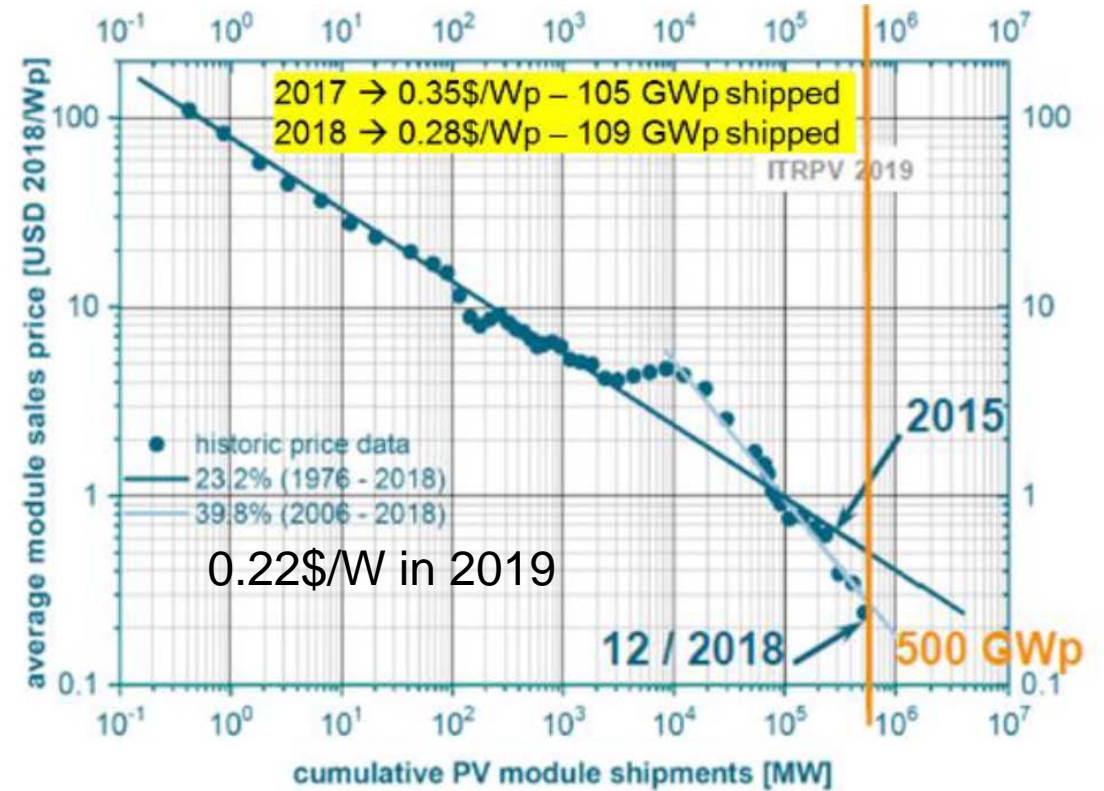


# PV Facts

- Photovoltaic (PV) energy is one of the most promising emerging renewable technologies
- Cumulative PV capacity grew at 49%/yr on average since 2003
- Total global capacity overtook 510 gigawatts (GW) in 2019



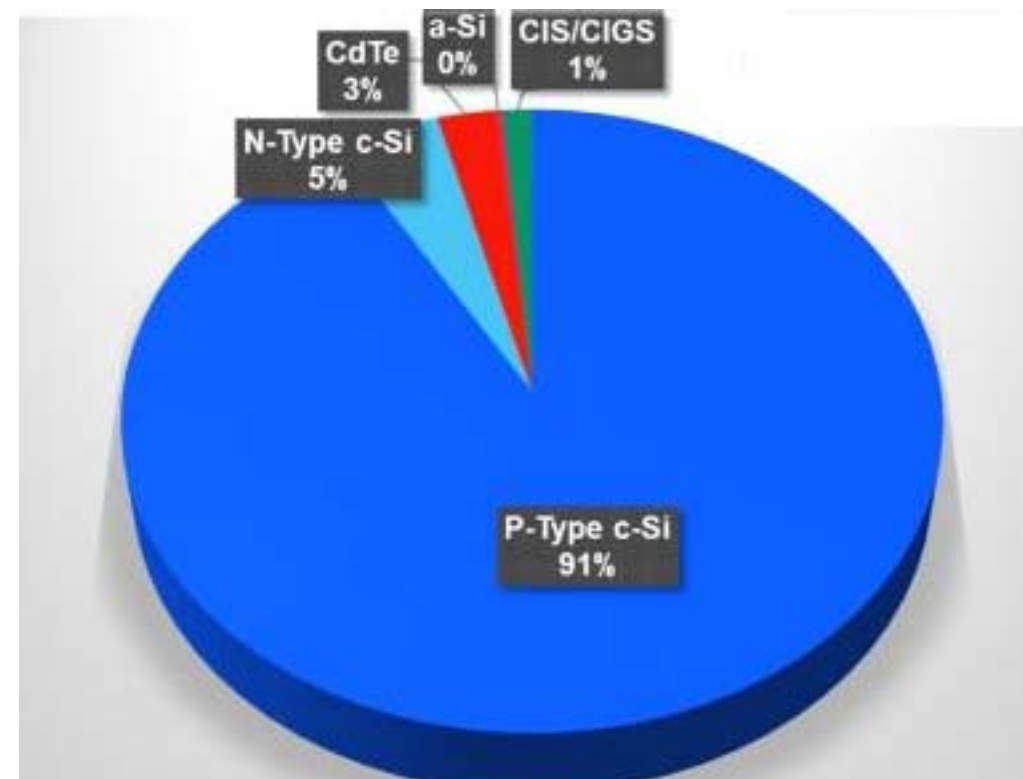
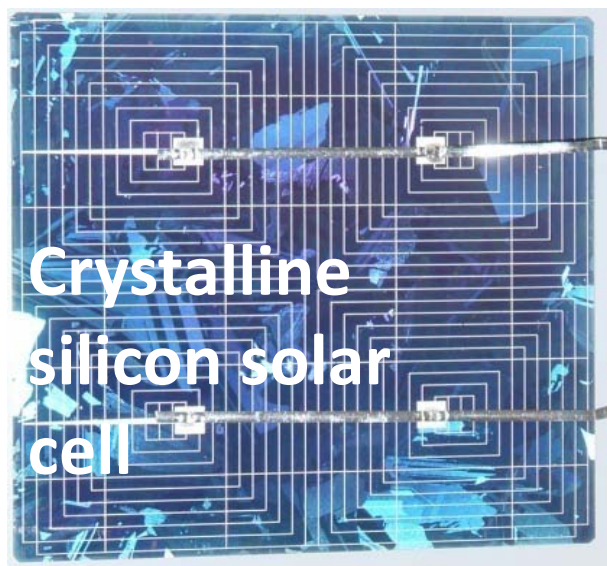
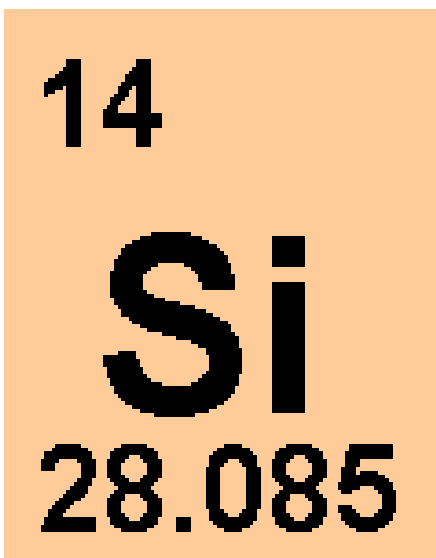
Source: International Energy Agency (IEA) , Bloomberg New Energy Finance



Key role for PV energy in the future

4 600 GW of installed PV capacity by 2050 would avoid the emission of up to 4 gigatonnes (Gt) of CO<sub>2</sub> annually

# Which technology is responsible for that ?



# From an historical point of view



Alexandre-Edmond Becquerel

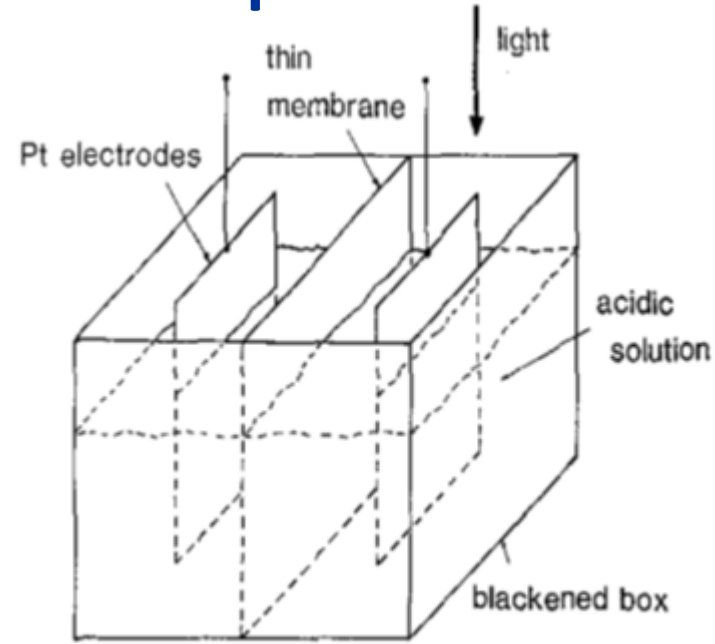
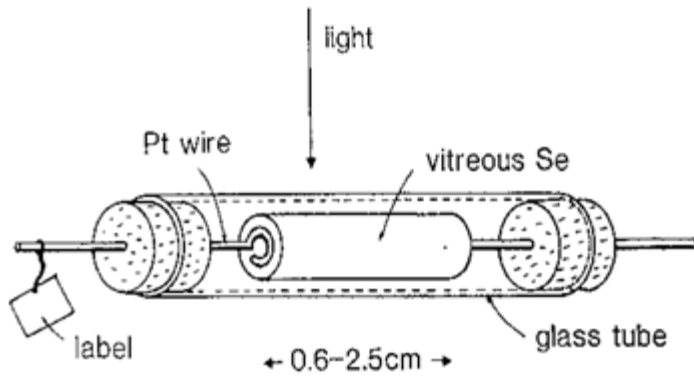
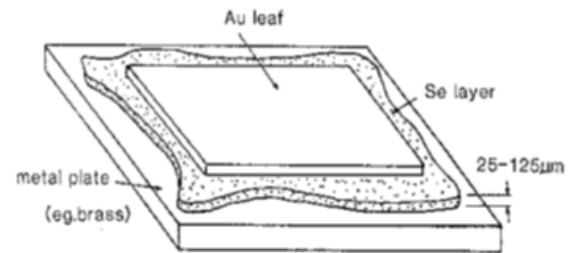


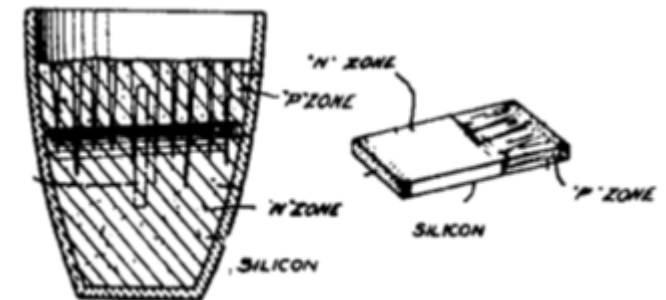
Diagram of apparatus described by Becquerel (1839)



: Sample geometry used by Adams and Day (1876)



Thin film selenium cell demonstrated by Fritts in 1883.  $\eta=1\%$

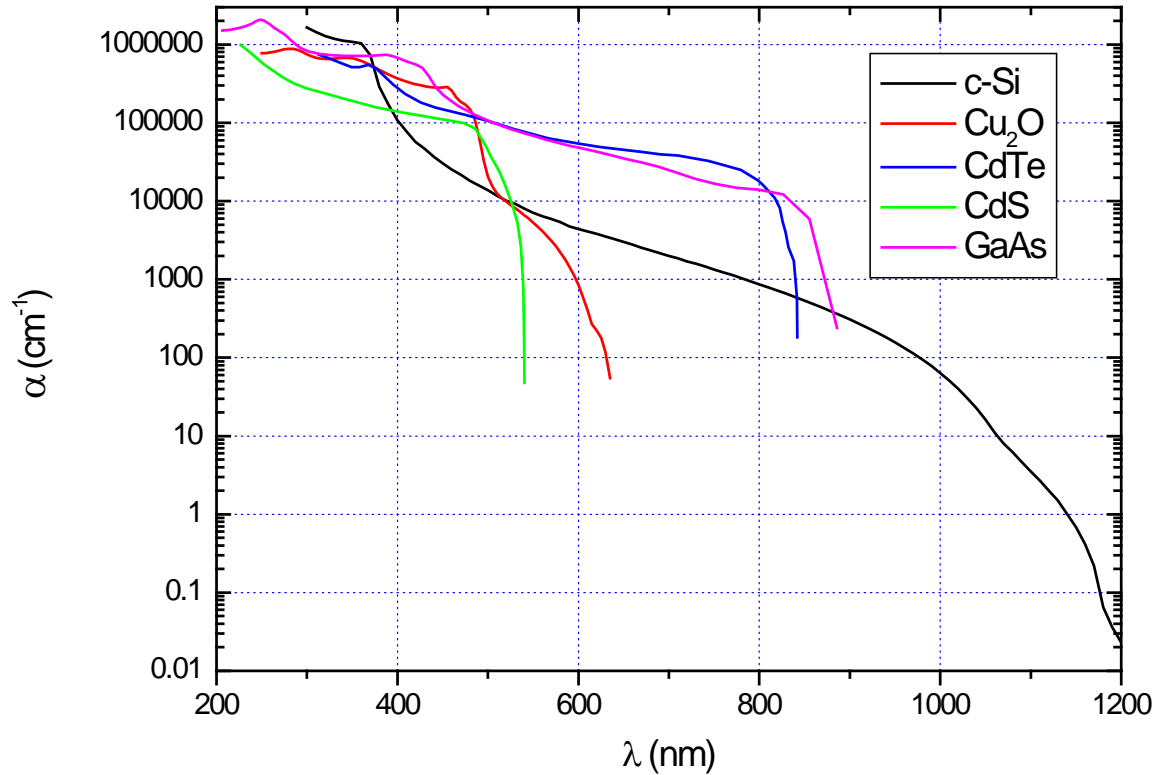


First silicon solar cell Ohl in 1941  $\eta=1\%$

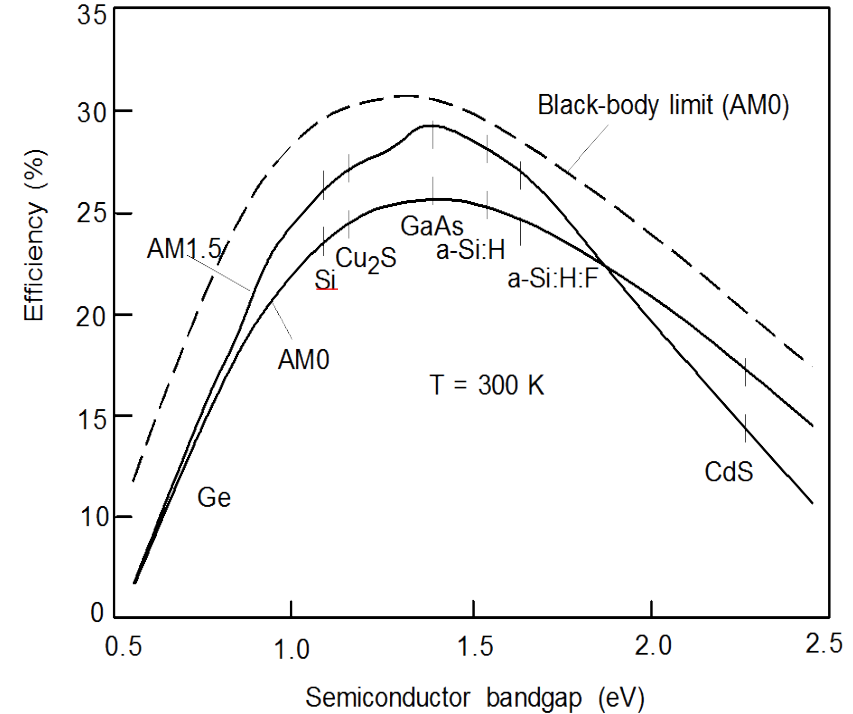
p-n junction based Si cell @ Bell laboratories in 1954  $\eta=6\%$

# From a physical properties point of view

Absorption



Energy gap



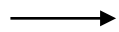
W.Schockley, H. Queisser JAP 32 (1961) 510

**Silicon is not the best material !**

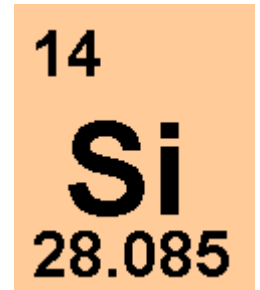


# Silicon solar cell's advantages

- ✓ Availability (Si is the 2° most abundant element )
- ✓ No toxicity
- ✓ Low cost (0.22 \$/W)
- ✓ Efficiency (26.7%) - module efficiency (18 % mc-Si- 22 % mono Si)
- ✓ Long lifetime (35 yr)
- ✓ Sustainability\*
- ✓ Recycling process (PV CYCLE achieves 96% recycling rate for silicon based PV modules)



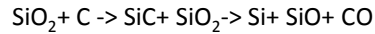
**Up to now Silicon has no competitors !**



\*Assuming 30 year system life Silicon PV systems will provide a net gain of 29 years of pollution free and greenhouse gas free electrical generation

# Silicon production

Si metallurgic production  
 From quartz and carbon



1- 3% of impurities



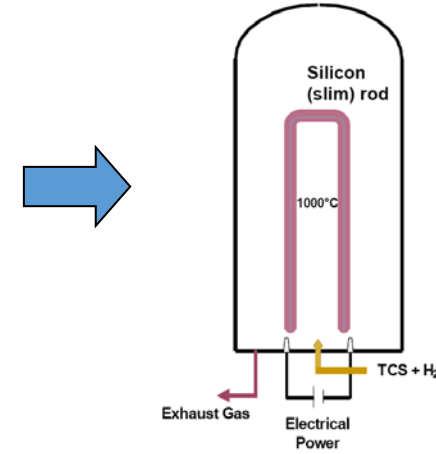
Si reaction with HCl

SiHCl<sub>3</sub> purification via distillation

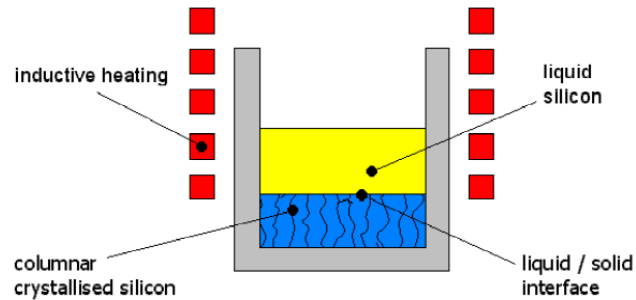


Electronic grade silicon

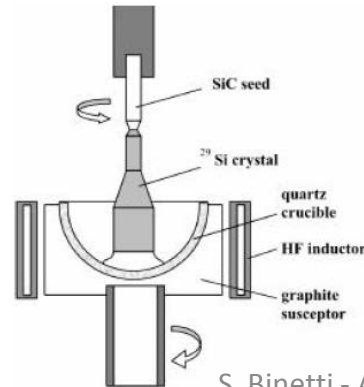
Polysilicon deposition



99,999999% (9N) or even 11N purity



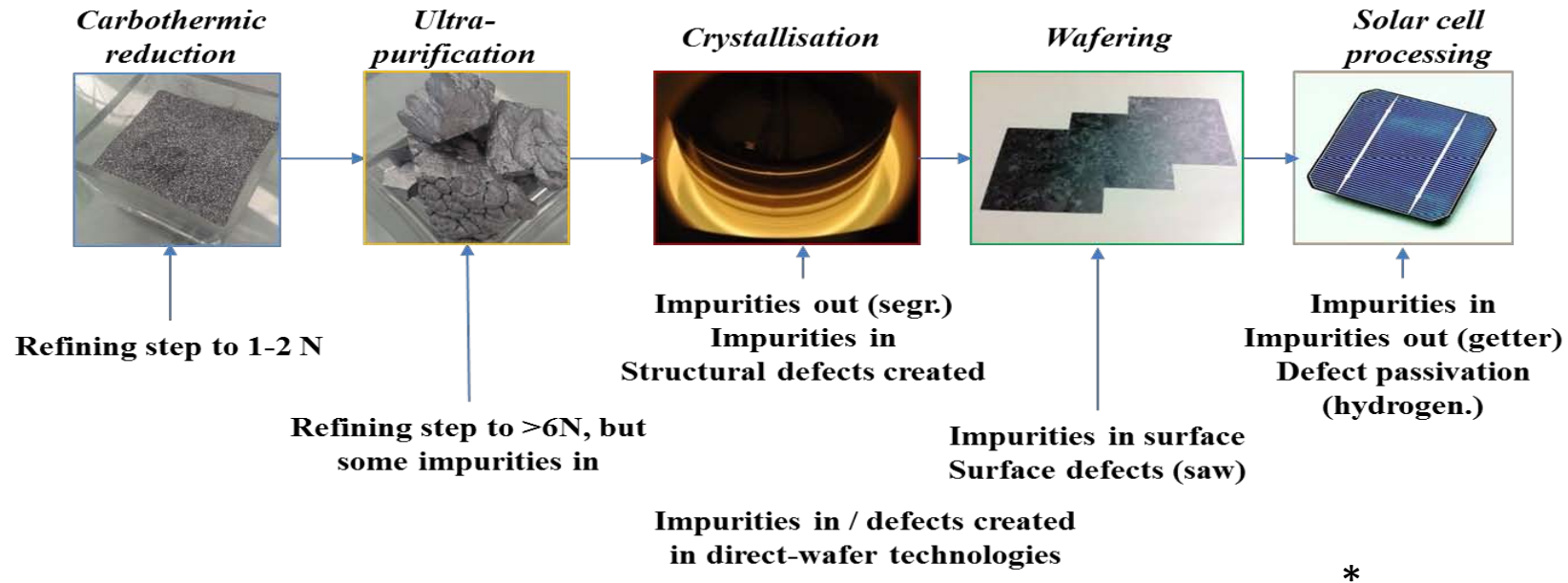
Si multicrystalline



Si monocrystalline

80% of 100.000 Si tons produced are for PV market

# Silicon solar cells



Producing the best quality feedstock is not the end of the story :

The process involves a number of steps, with the potential incorporation of contaminants, but with the opportunity to rearrange the impurities

The optimization of every step of the process was the **key** of the Si solar cell's success

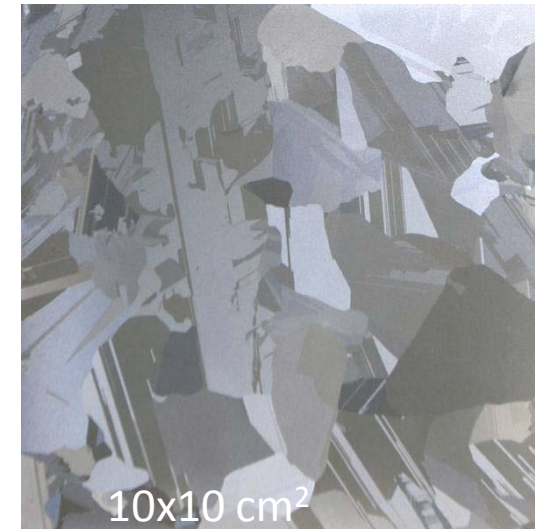
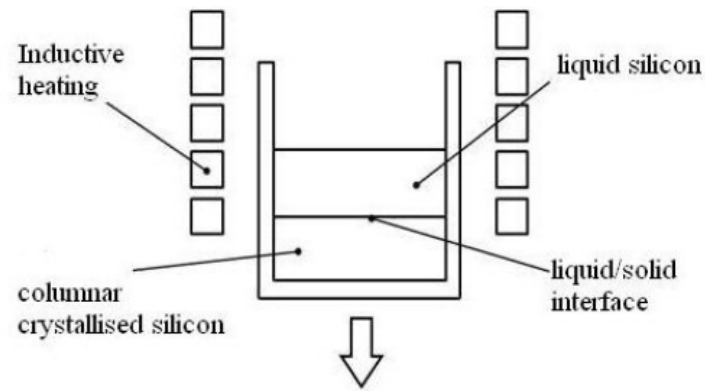
\*C.Del Canizo, S. Binetti, T. Buonassisi in "Purity Requirements for silicon in PV application "  
 Solar Silicon Processes: Technologies, Challenges, and Opportunities CRC press (2016)

Important Role of Chemistry !



# Multicrystalline silicon growth process

DS growth process avoids the costly pulling system



$\eta = 22\%$

High density of dislocations and grain boundaries

[B] =  $10^{16} - 10^{17}$  at/cm<sup>3</sup>

[O] = 1 -20 ppma ; [C] = 1-10 ppma ; [Fe] <  $10^{15}$  at/cm<sup>3</sup>

Poly Silicon Casting



Multi-Crystalline Silicon Ingot



Blocking Silicon

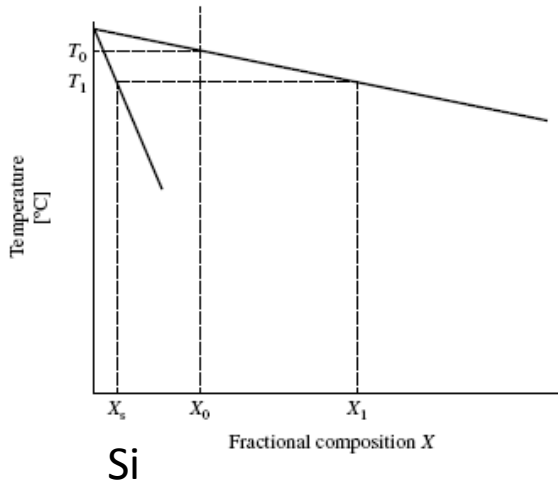


Silicon Brick



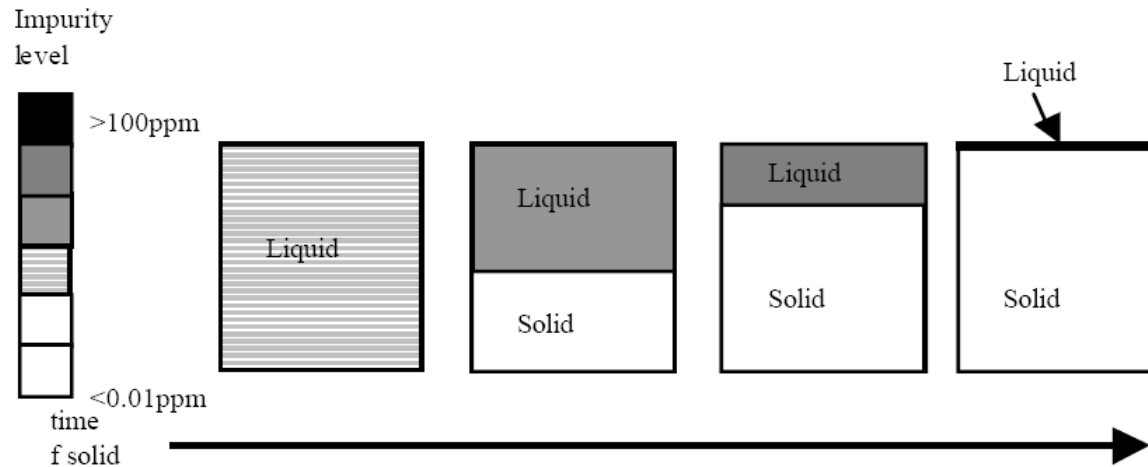
The silicon blocks are sawn into wafers by multiwire sawing

# Purification by crystallization



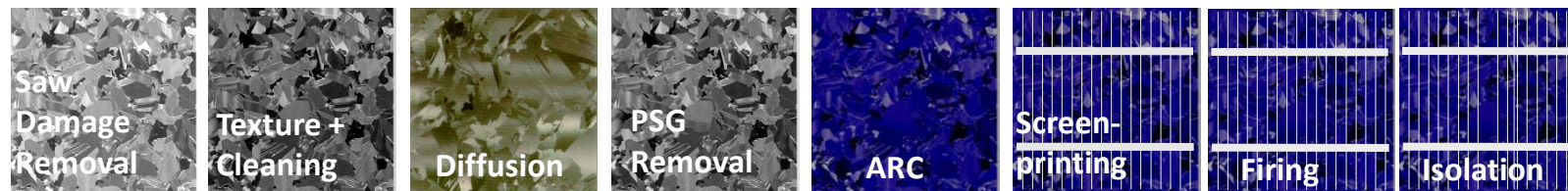
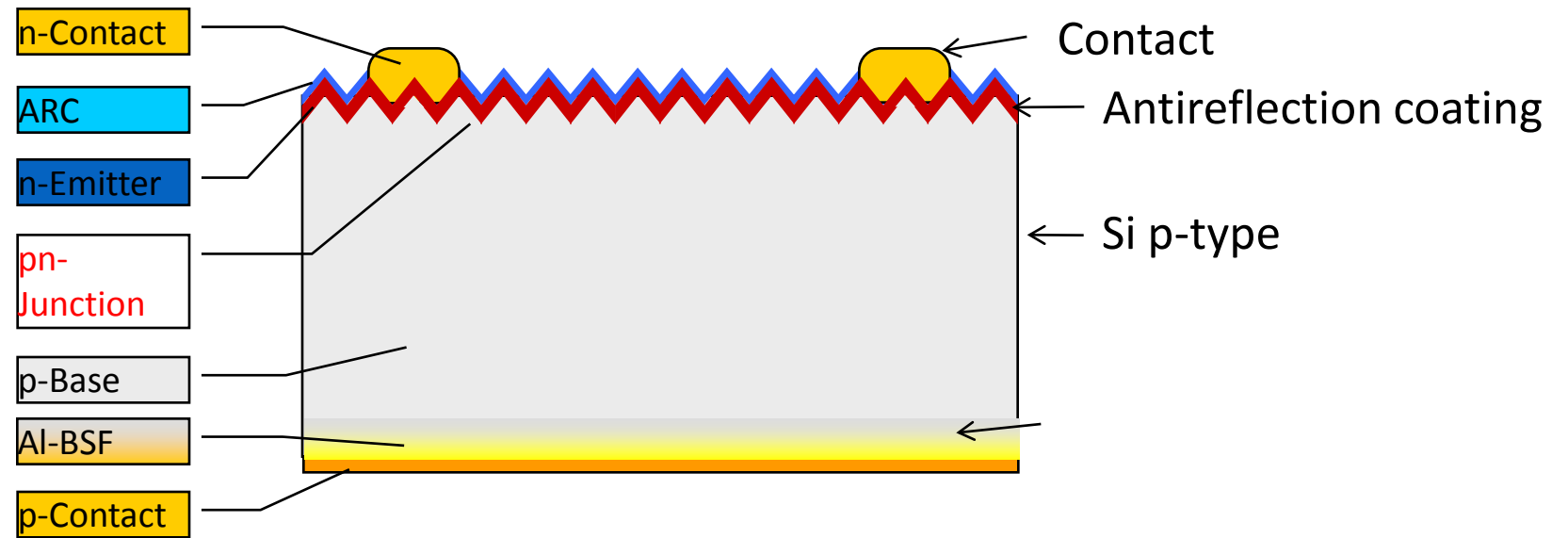
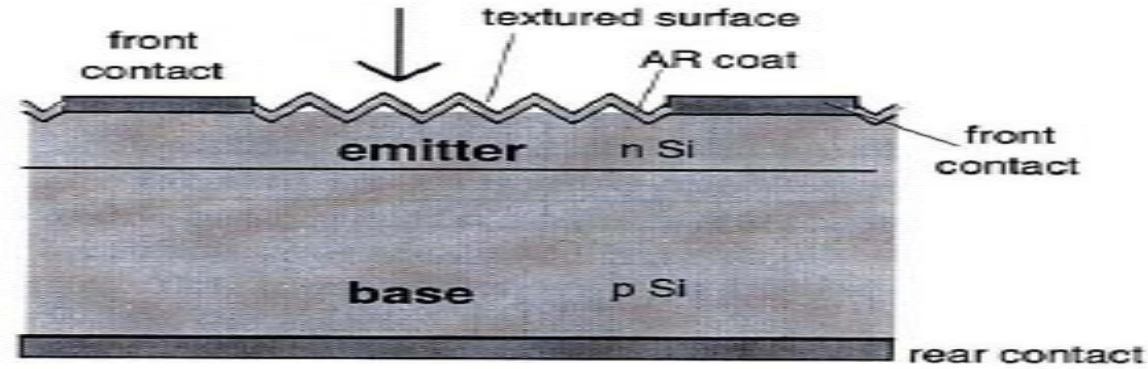
Segregation coefficient of metals

$$K = \frac{C_s}{C_l} < 1$$



Reduction of metal impurities up to less than few ppma

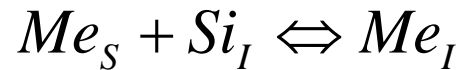
# Silicon solar cell's process: state of the art



# Junction formation: positive impact

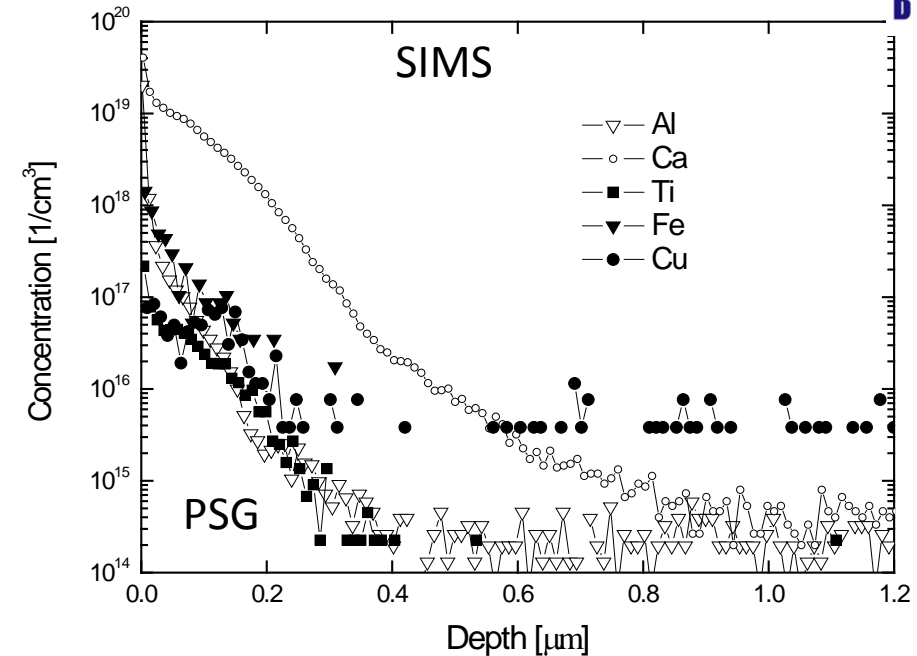
Annealing in nitrogen saturated with phosphorous oxychloride ( $\text{POCl}_3$ )

Lifetime increases by P gettering process

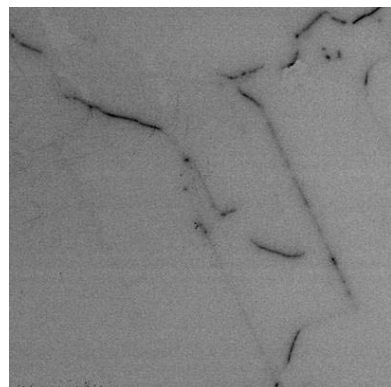


Injection of point defects and diffusion versus the PSG layer of metals

In mc-Si: impact of impurities segregation on electrical activities of defects

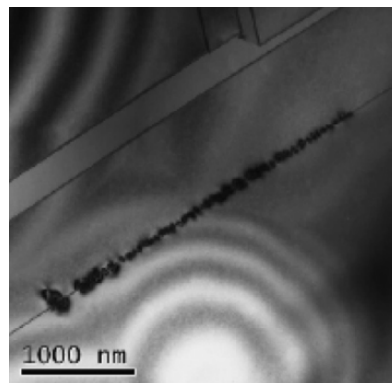


E.B.I.C.



SEM MAG: 150 x  
 HV: 20.0 kV  
 VAC: HVac  
 DET: EBIC  
 DATE: 05/26/05  
 Device: TS5136XM  
 Vega ©Tescan  
 Digital Microscopy Imaging

TEM



S. Pizzini et al. *J. Electrochem. Soc.*, vol. 135, no. 1, pp. 155–165, 1988.

M. Acciarri, & S. Binetti et al. *Prog in PV* (2007)

J. Libal & S. Binetti et al *JAP* **104**, 104507 2008

S. Binetti et al. *Materials Science & Engineering B* **159**, (2009) 274

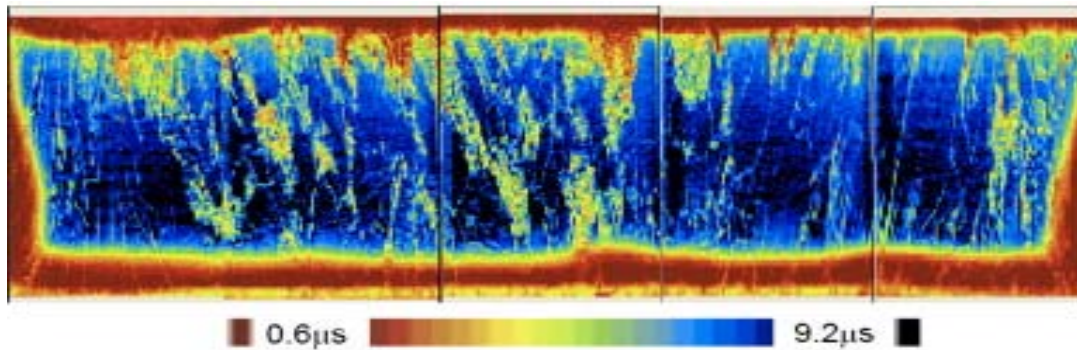


# Antireflection coating: positive impact

Incorporation of atomic hydrogen from the SiNx:H anti-reflection coating and its diffusion into the bulk : Passivation of dislocations and Grain boundaries

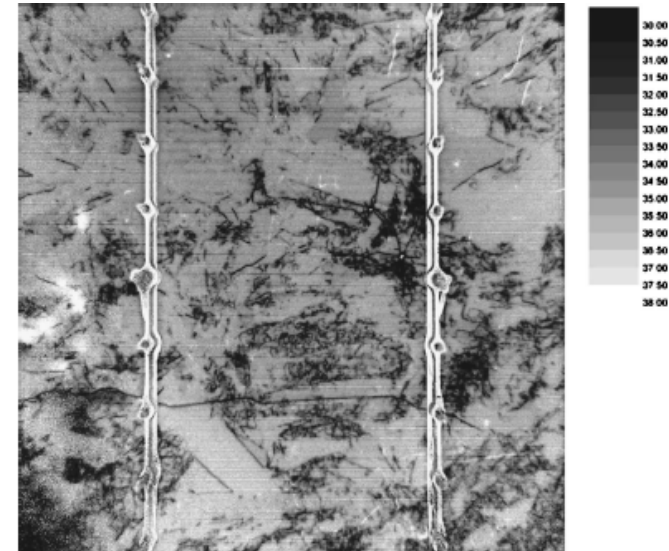
All the process has been optimized also by developing of **analytically in line tools** like PL mapping , PV scans or  $\mu$ PCD

Lifetime mapping of a mc-Si ingot



S. Binetti et al. , Materials Sci. Eng. B 36, 68 (1996)

PL map



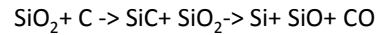
T. Trupke et al. Appl. Phys. Lett., 044107, (2006)

S. Binetti et al. Solmat 130 (2014 )696



# Silicon production

Si metallurgic production  
From quartz and carbon



1- 3% of impurities

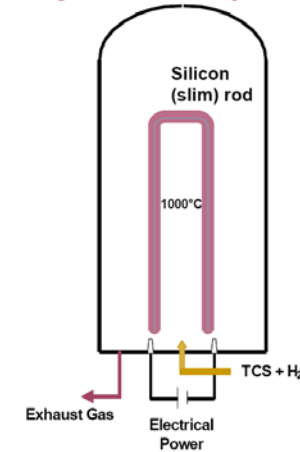


$\text{SiHCl}_3$  purification via distillation



Electronic grade silicon

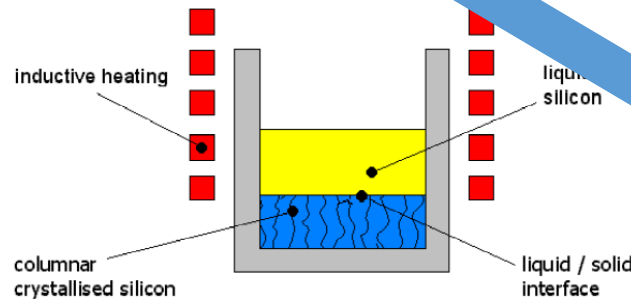
Polysilicon deposition



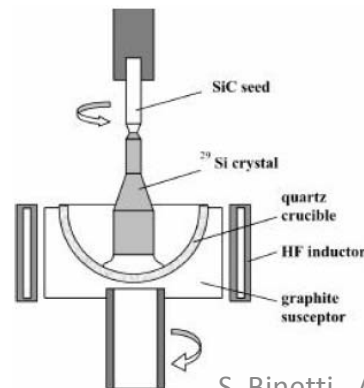
99,999999% (9N) or even 11N purity



Si reaction with HCl



Si multicrystalline

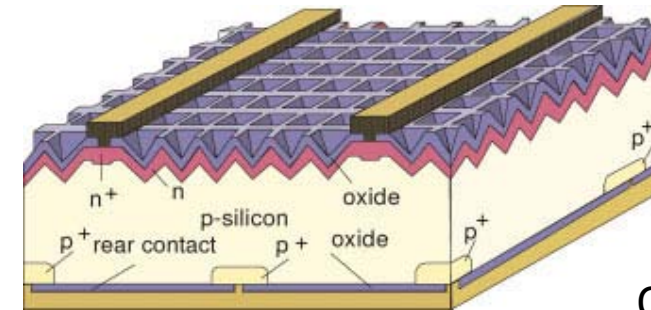


mc-Si :

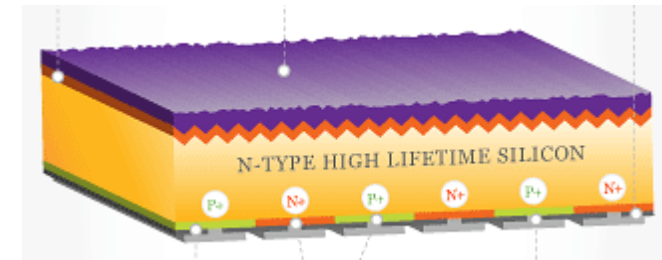
- possibility of using Up graded MG silicon ( $\eta = 19\%$ )
- new advanced casting technologies under development

# The technology has led us towards higher efficiency solar cells

- PERL cells (by UNSW)
  - record of efficiency: 26.7 %
  - Commercial efficiency:  $\eta=22\%$  (*Suntech*)

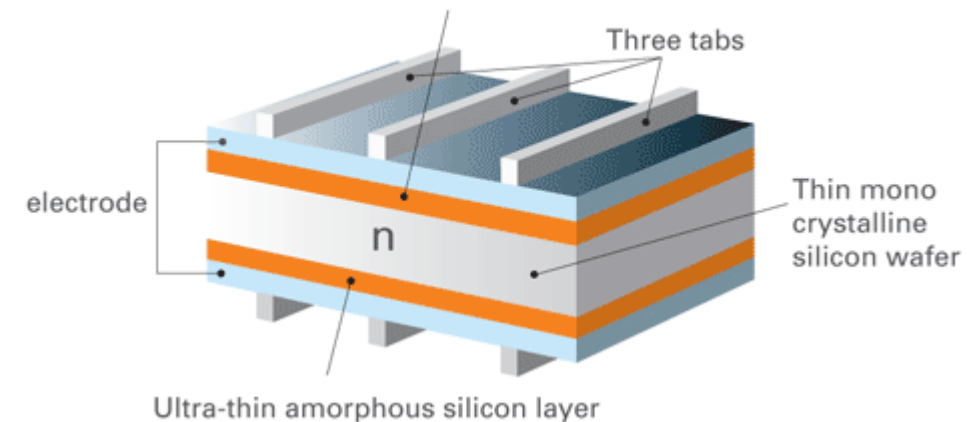


- Based on n type Silicon :
  - commercial  $\eta=25.5\%$  (*Sunpower*)



HIT<sup>®</sup> Solar Cell Structure  
Ultra-thin amorphous silicon layer

- HIT structure : c-Si with a double a-Si/c-Si heterojunction on n-type (*Sharp -Sanyo*)
  - $\eta= 25.6\%$  (R&D)
  - $\eta=21\%$  (in production)



- Optimizing :
- ✓ Texturization
  - ✓ Surface passivation
  - ✓ Contacts
  - ✓ Material lifetime
  - ✓ Junction

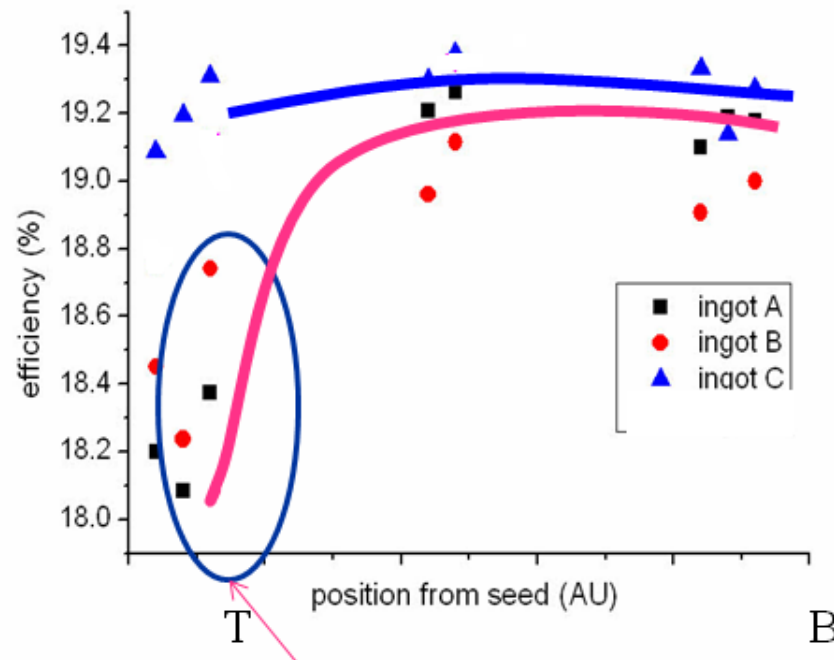
**Efficiency is very close to the maximum value (28%)**

# Current research activity: closing the gap and studying the remaining defects

Ingot	Ingot Classification	Doping	Resistivity [Ωcm]	O <sub>i</sub> [ppma]
A	Reference	n-type	1 – 5	<18 , 7.8 -8.6 at /cm <sup>3</sup>
B	Low Grade Polysilicon	n-type	1 – 5	<18 8.1- 9.3 at /cm <sup>3</sup>
C	Low Oxygen level	n-type	1 - 5	<16 7.2 -7.6 at /cm <sup>3</sup>

Standard **n-type** cell processing on wafers coming from different CZ ingots and ingot positions

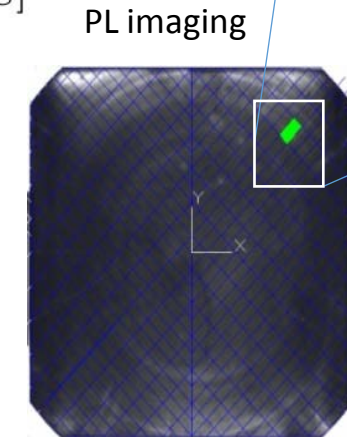
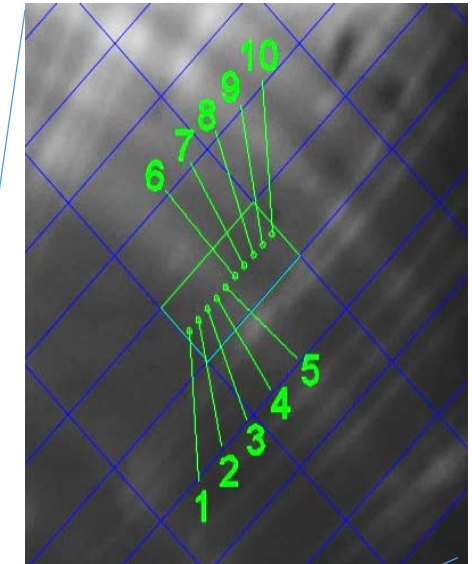
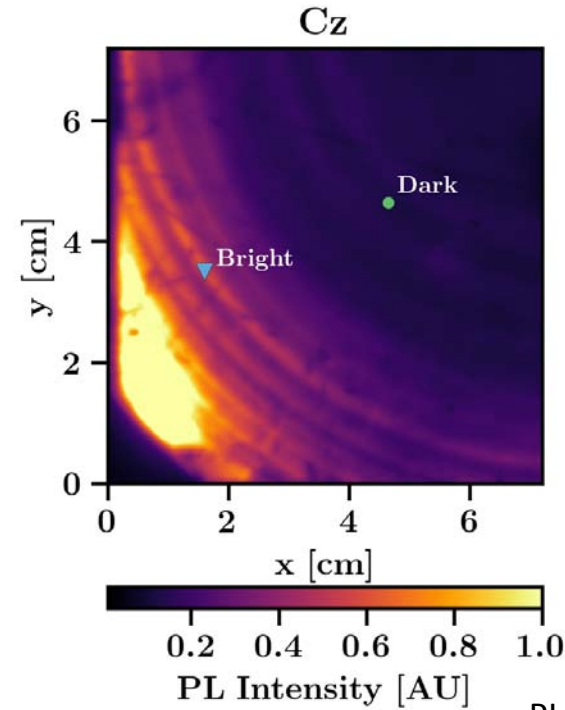
Cells of ingot A,B show evidence of decrease of  $\eta$  % in the seed side  
(High oxygen concentration)



G. Colletti et al. Solmat 130, 647 (2014) ; A.Le Donne, S. Binetti \*, et al . Applied Physics Letter 109, (2016), 033907

# The reason behind the decrease in efficiency

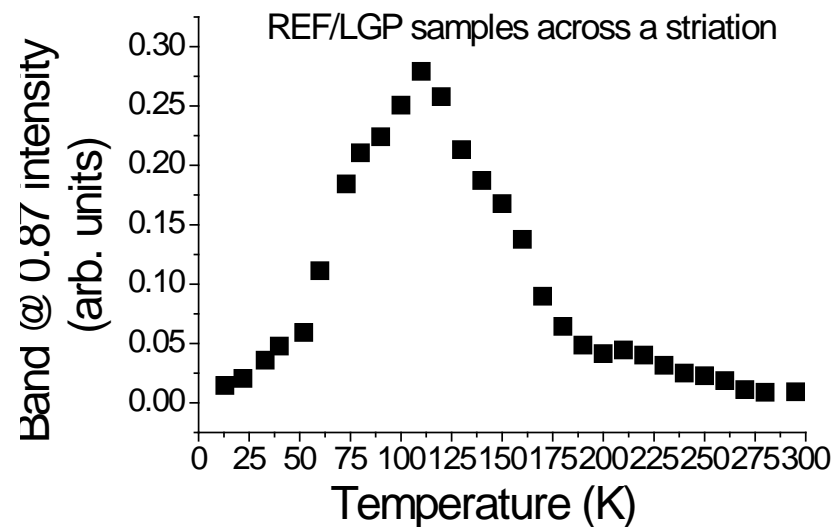
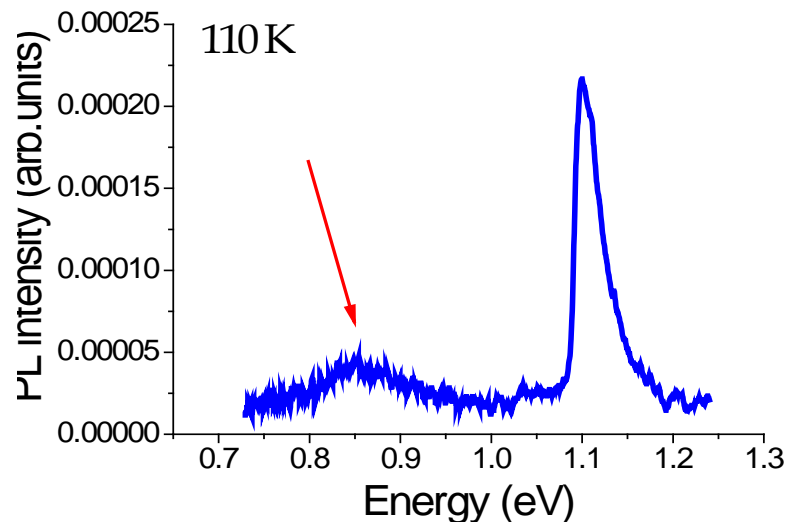
- Room Temperature PL images of the band-to-band (BB) emission shows the bright/dark rings (striations)
- Dark striations correspond to lower effective minority carrier lifetime than the bright striations.
- No direct correlation exists between the feedstock quality and the occurrence of striations (Absence of striations in the middle and bottom wafers of the REF/LGP ingots and in the whole LOO)



A. Le Donne, S. Binetti \* & G. Coletti Applied Physics Letter 109, (2016), 033907

# Photoluminescence results

On striations



Position of the band (0.87eV ) and temperature dependence associated to oxide precipitates

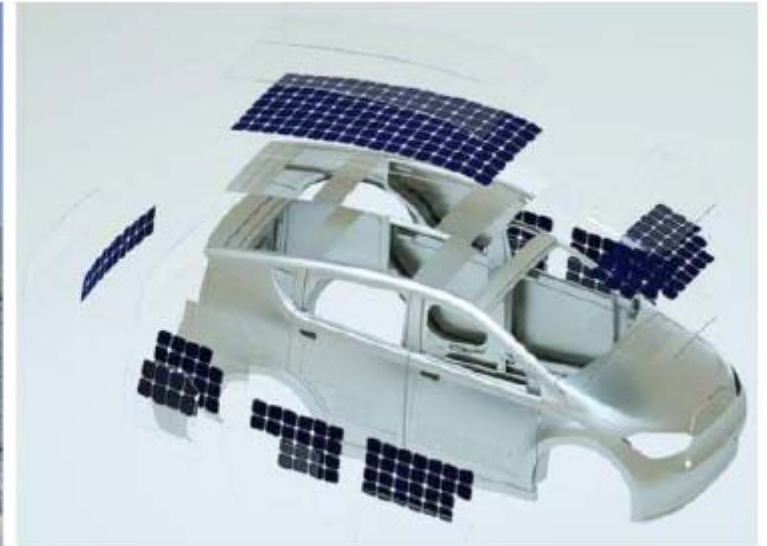
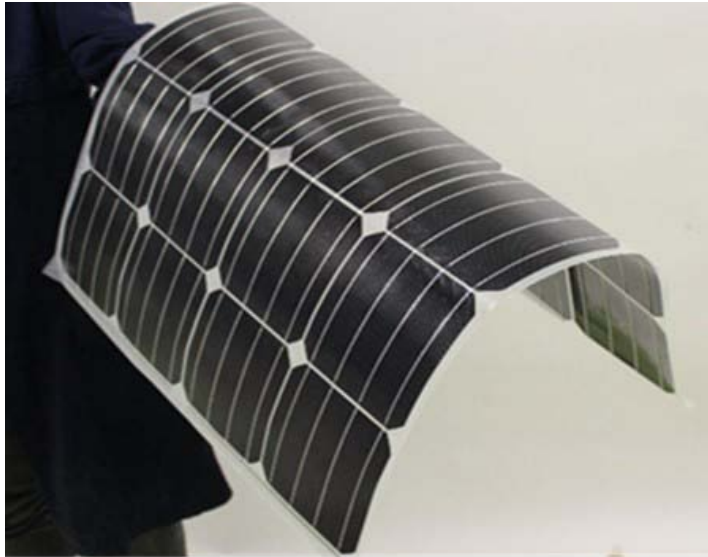
SiO<sub>x</sub> nanoprecipitates (density about 10<sup>11</sup> cm<sup>-3</sup>) formed during the pulling growth are responsible of the efficiency's decreases

Possible solution: dissolution treatment



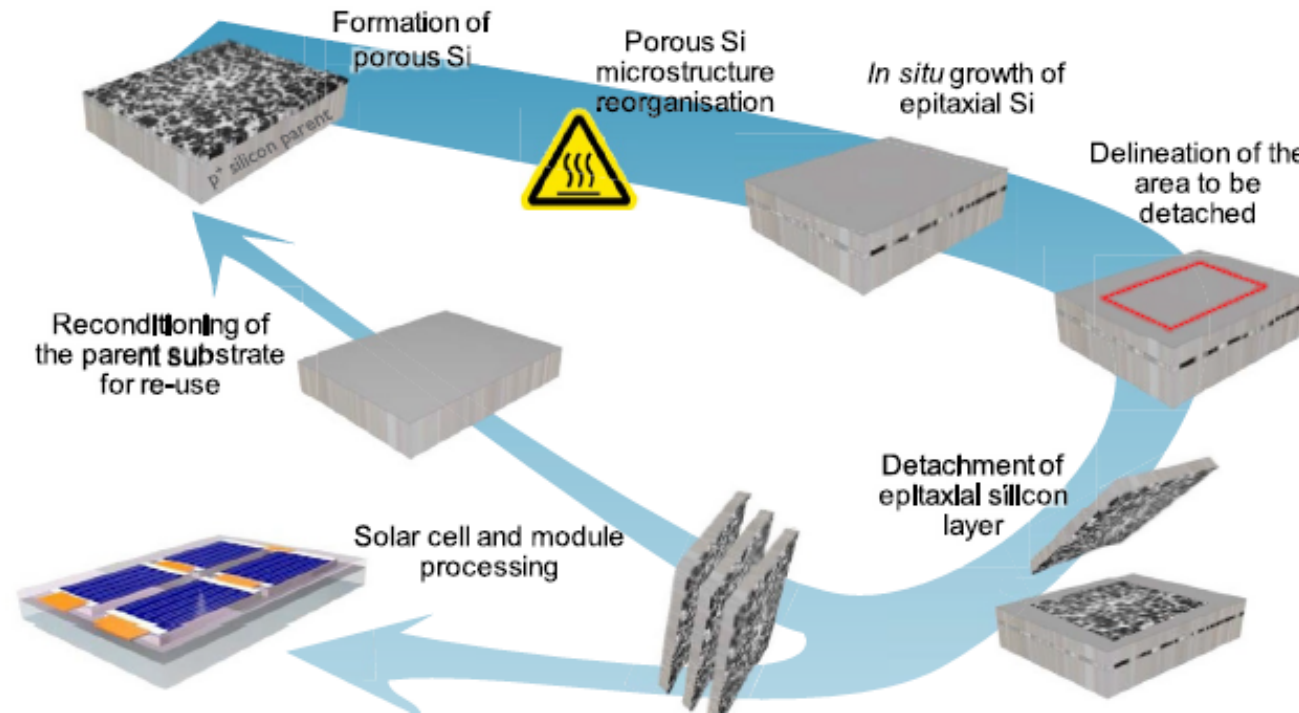
## What's next ?

### Silicon for Product or Building Integration Photovoltaic and Vehicle Integration PV (VIPV)



# Flexible Si modules with efficiency > 20 %

Huge cost saving potential for Si PV by using less Si per module and by reducing energy consumption



$\eta = 20.6\%$  43  $\mu\text{m}$  thick ; 156x156  $\text{mm}^2$  by ISE- Fraunhofer

# What's next?

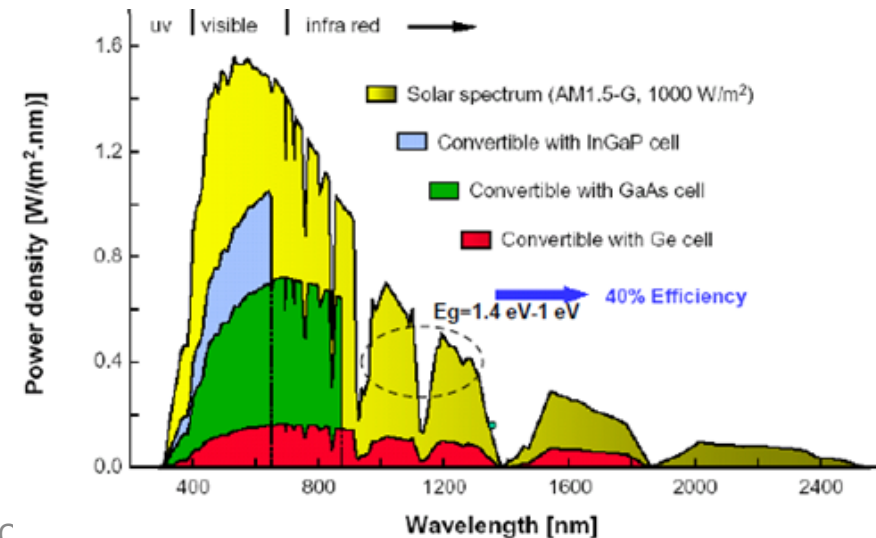
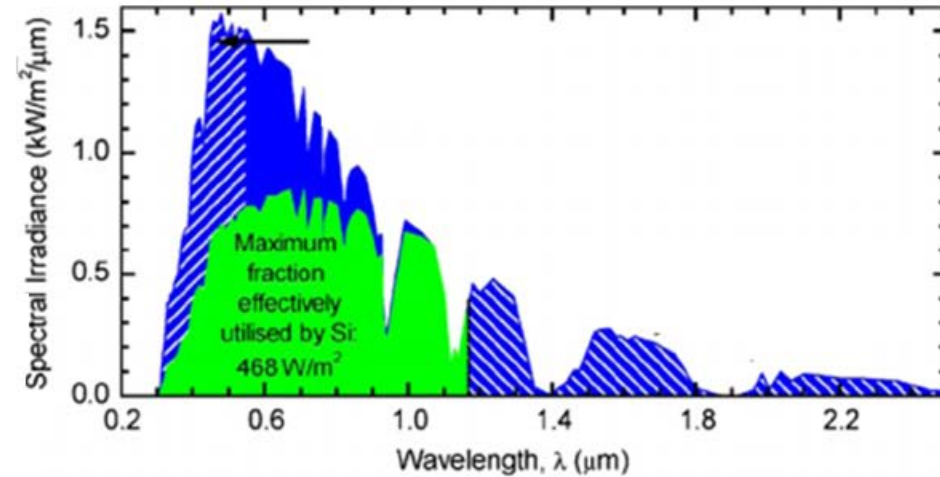
Overcoming the single junction limit (28%)

Aiming to approach the thermodynamic limit

$$\eta = 1 - \frac{T_2}{T_1} = 1 - \frac{5778}{300} = 93\%$$



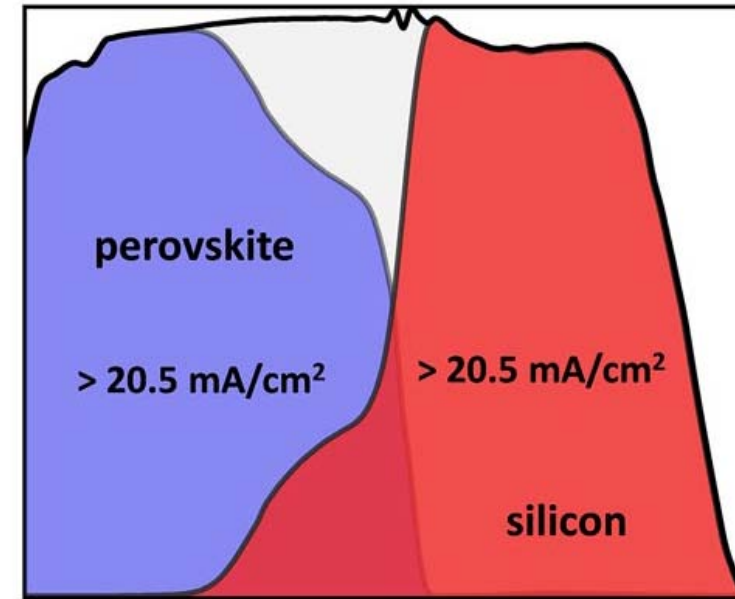
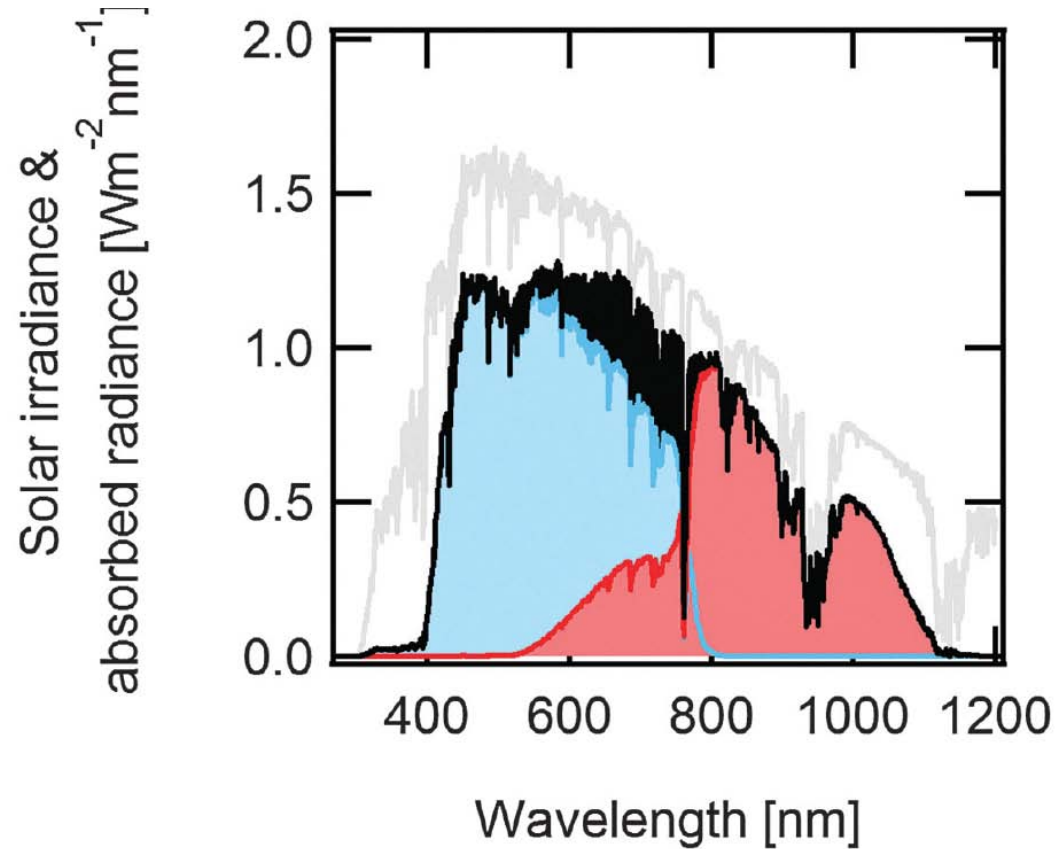
Multijunction solar cells concept



# Tandem solar cell

Theoretical efficiencies up to 44 % @1 SUN

Perovskite on silicon

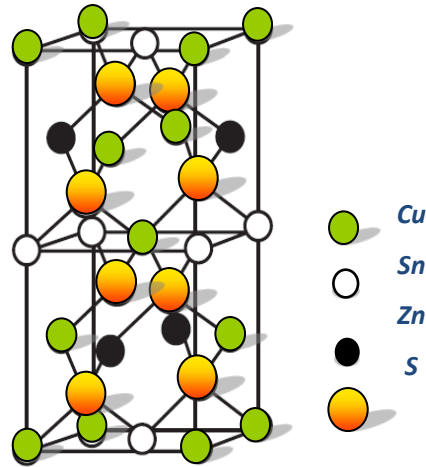


Oxford PV's 1 cm<sup>2</sup> perovskite-silicon tandem solar cell has achieved a 28% conversion efficiency

**Main open questions: lifetime and stability**

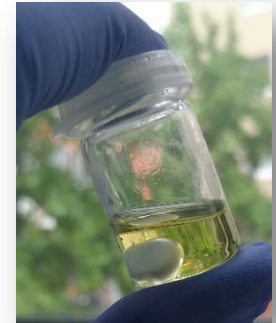


# Cu<sub>2</sub>ZnSnS<sub>4</sub> for Si tandem solar cell



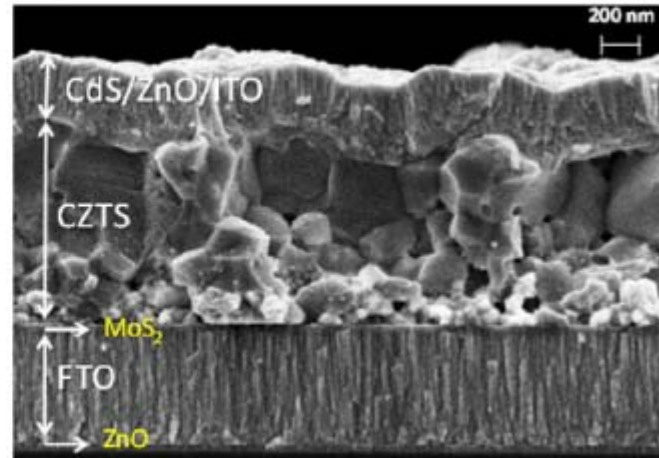
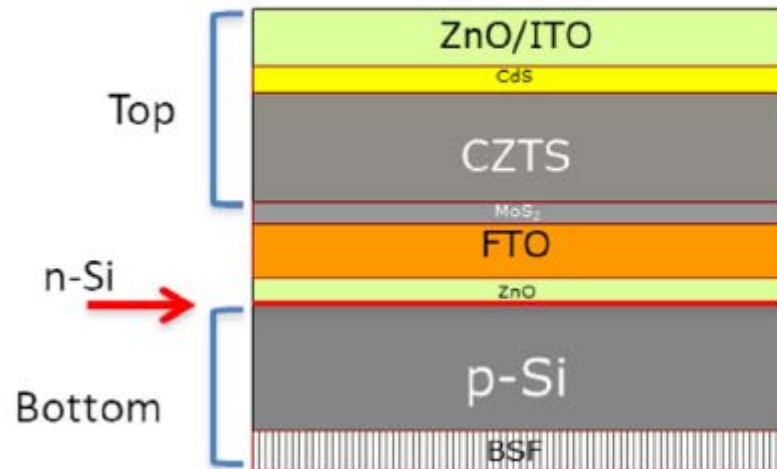
- Cu<sub>2</sub>ZnSnS<sub>4</sub> (CZTS) Environmentally friendly, low cost, many deposition methods
- High stability
- E<sub>g</sub> can be tuned between 1.45 and 1.65 eV (DIRECT)
- High absorption coefficient (> 10<sup>4</sup> cm<sup>-1</sup>)
- Efficiency record  $\eta_{\text{record}} = 11\%$  \* (CZTS) - 12.6% (CZTSSe)

\*C.Yan et al. Nature Energy 2019, 3- 764



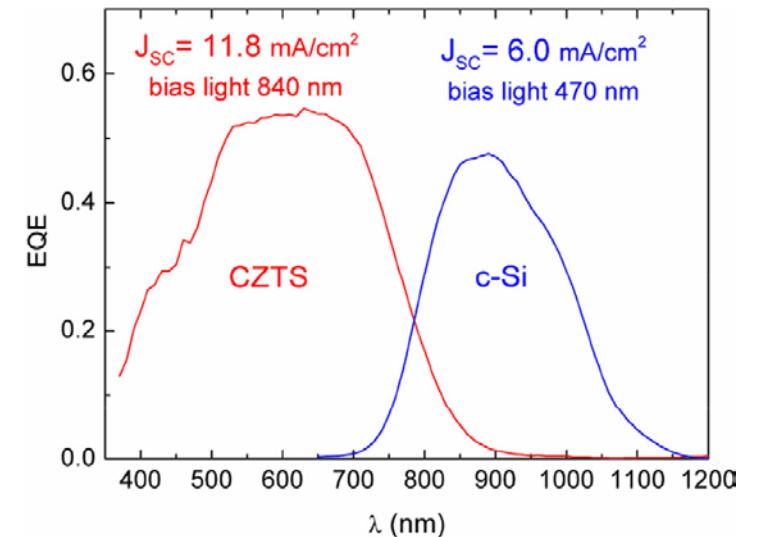
The first working monolithic tandem cell, with Voc = 950 mV and  $\eta = 3.5\%$ ,

M. Valentini et al. Solar Energy 190 (2019) 414–419



S. Binetti - AVOGADRO COLLOQUIA 2019 - Roma

V. Trifiletti et al., Chemistry Select 2019, 4, (17), 4905-4912.





# Silicon based solar cells' evolution

- 1950s: development of both crystal growth and junction diffusion techniques
- 1970s: development of shallow junctions, photolithographically metallisation, antireflection coatings and surface texturing.
- 1980-2000: improvements in mc-Si , surface and contact passivation, bulk lifetimes
- 2000-2022: further optimization reaching the theoretical limit also in modules
- 2020–2030: flexible Si modules & tandem Si-solar cells
- 2030 - ?: building cells with Si from end of life modules: 1.7 millions of tons in 2030

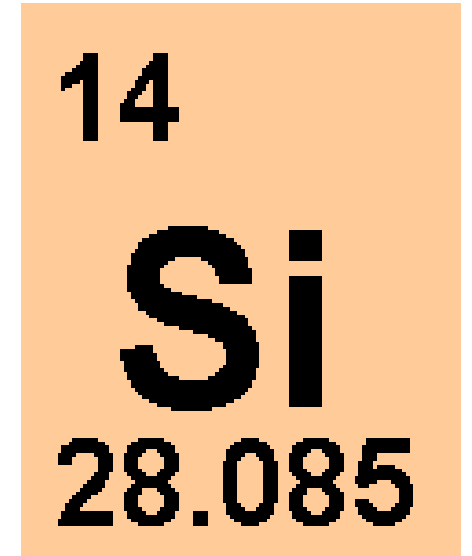
**There is still room for chemistry-related research activity**

# Acknowledgements



## Si-related European projects

- 1990-1993 EU project “Concepts for high efficiency multicrystalline silicon solar cells (Multi-Chess I)
- 1993-1996 EU project “Concepts for high efficiency multicrystalline silicon solar cells (Multi-Chess II)
- 1996-1999 EU “Cost Effective Solar Silicon Tecnology (COSST)
- 2000-2003 FP5 Fast in Line characterization tools for crystalline silicon material and cell process quality control in the PV industry (FAST-IQ)
- 2002-2005 FP5 N-type Solar Grade Silicon for Efficient Solar Cells (NESSI)
- 2005-2008 FP6 "Nanocrystalline silicon film for Photovoltaic and Optoelectronic application (NanoPhoto)
- 2014-2017 FP7 “Cost-reduction through material optimisation and Higher EnErgy output of solAr PV modules (CHEETACH)



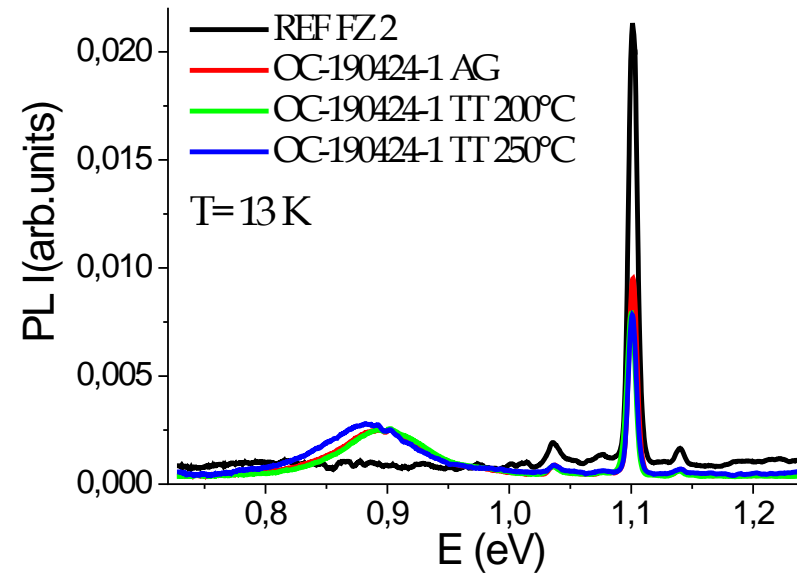
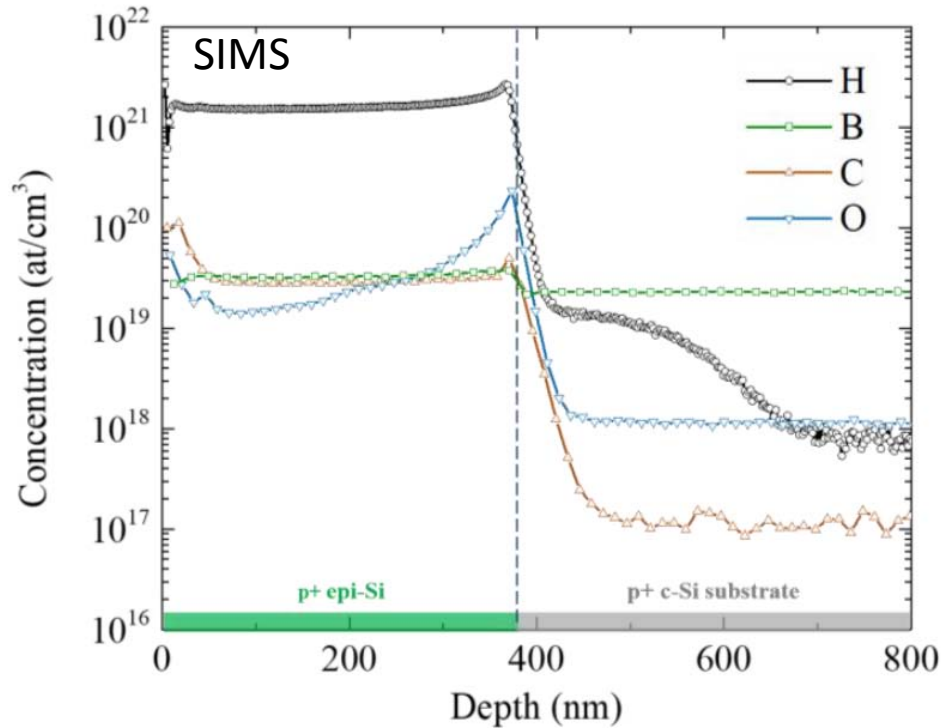
**Thank you for your kind attention**

# Backup

# Boron emitter p<sup>+</sup> epi –Si by low temperature PECVD

Advantages: lower thermal budget, control of doping profile

Several epi layers annealed from 175 -220 °C (B-H)



Platelets like extended defects due to H\*

HTREM measurement in progress

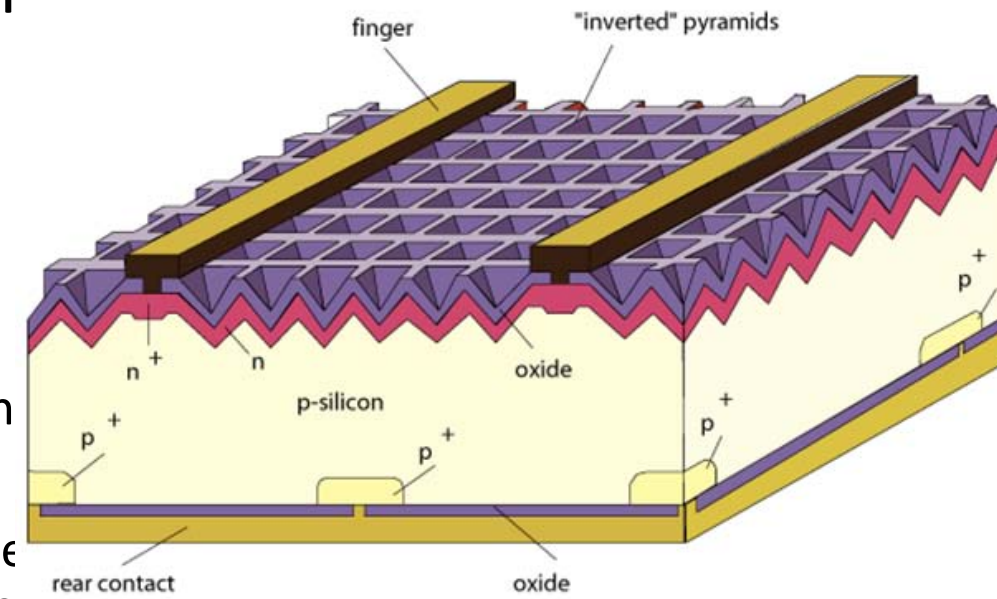
M. Chrostowski , J.Alvarez , A. Le Donne, S. Binetti, Pere Roca Cabarrocas , Materials 2019, 12(22), 3795



# High efficiency solar cells :

- **PERL (Passivated Emitter Rear Locally diffused cell)** developed by UNSW in 1990

1. top surfaces is textured with inverted pyramid structures
2. double layer ARC (MgF<sub>2</sub> and ZnS)
3. reduction of the contact area at the front side to reduce the shading losses
4. In the emitter: high doping under the front metal grid to reduce the related contact resistance and low doping for the rest of the emitter. Then the uncovered emitter is also easy to passivate.
5. Back contact optimized by point contacts and passivation layers

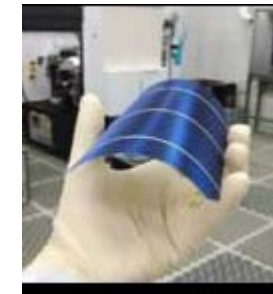
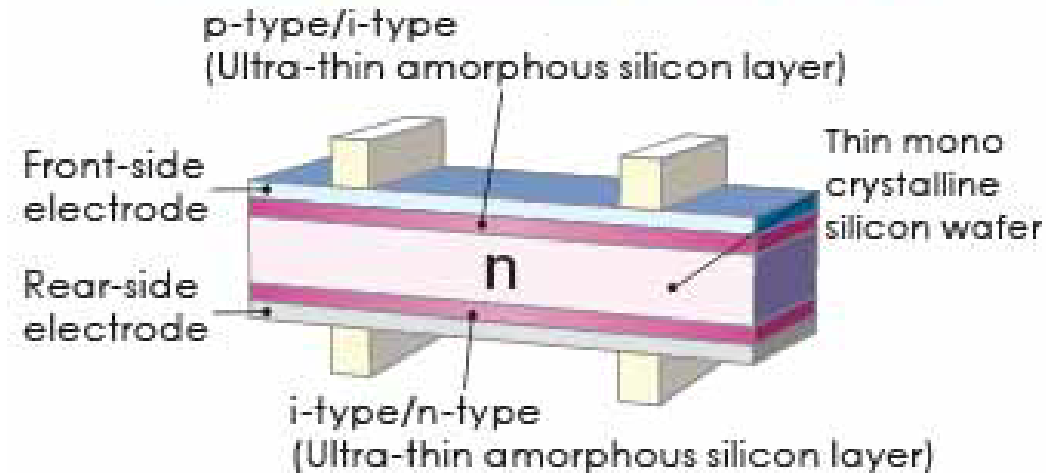


$$\eta=25.5 \%$$

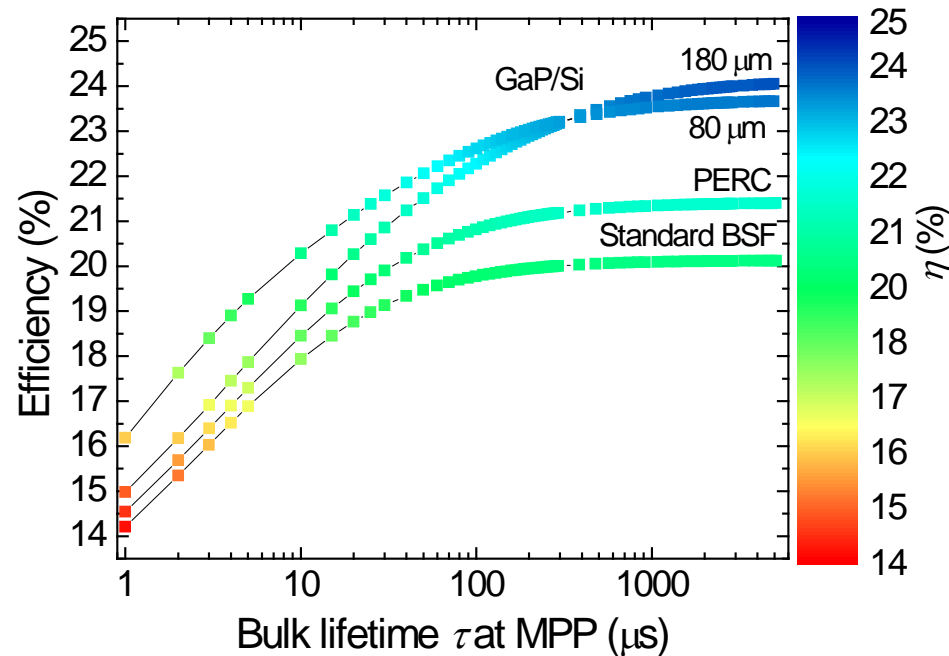
# HIT cell

- Several advantages:
  1. a high open circuit voltage due to the potentiality of HJ and due to the good silicon surface passivation promoted by the a-Si:H layer,
  2. No high treatment
  3. Amorphous layer works as a passivating layers
  4. a better response as a function of the operating temperature with respect to conventional silicon base

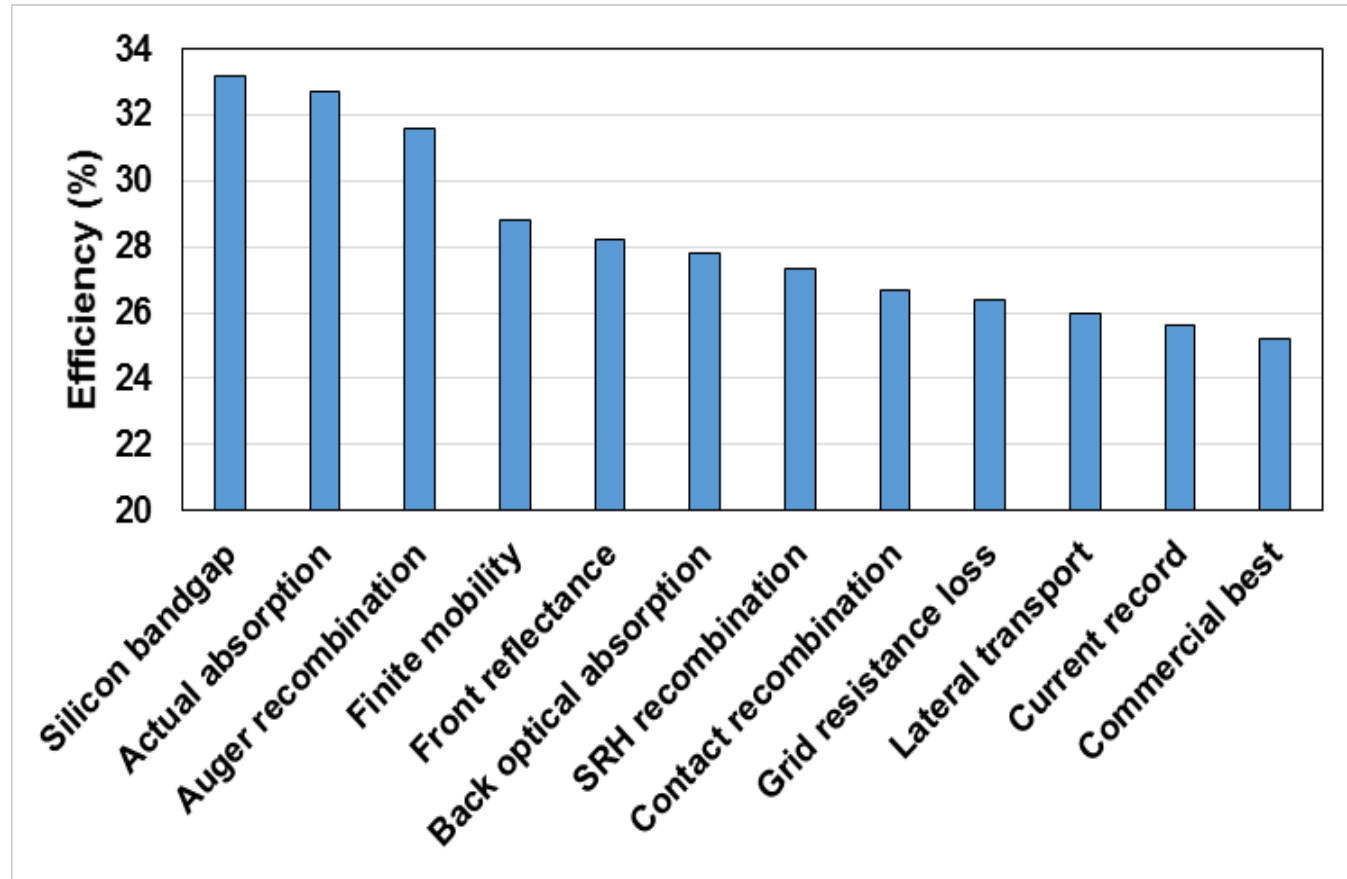
## SANYO HIT<sup>®</sup> Solar Cell Structure



X 100  $\mu$ m



- Given a substrate with a certain concentration of impurities and defects at the end of the cell process, which translates in a certain lifetime, Figure indicates the efficiency that can be achieved, depending on the cell architecture





# High quality CZTS thin films by wet process

Aim: Develop a simple , cheap , no toxic process based on the sol-gel technique

## Molecular inks :

CZTSsol was prepared by dissolving in DMSO:

- $\text{Cu}(\text{CH}_3\text{COO})_2 \cdot \text{H}_2\text{O}$ ;
- $\text{SnCl}_2 \cdot 2\text{H}_2\text{O}$ ;
- $\text{Zn}(\text{CH}_3\text{COO})_2 \cdot 2\text{H}_2\text{O}$ .

After complete dissolution, thiourea was added.



We investigated the composition and stability of the molecular ink

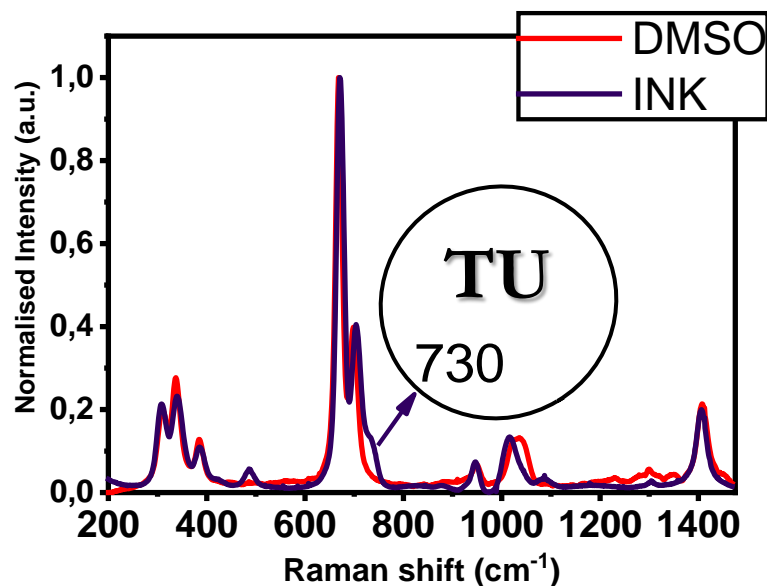
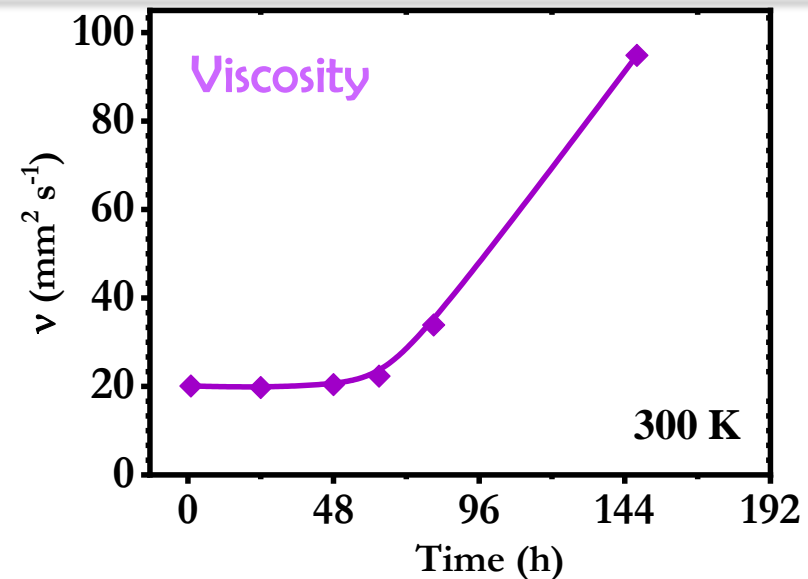
V. Trifiletti et al., Chemistry Select 2019, 4, (17), 4905-4912.



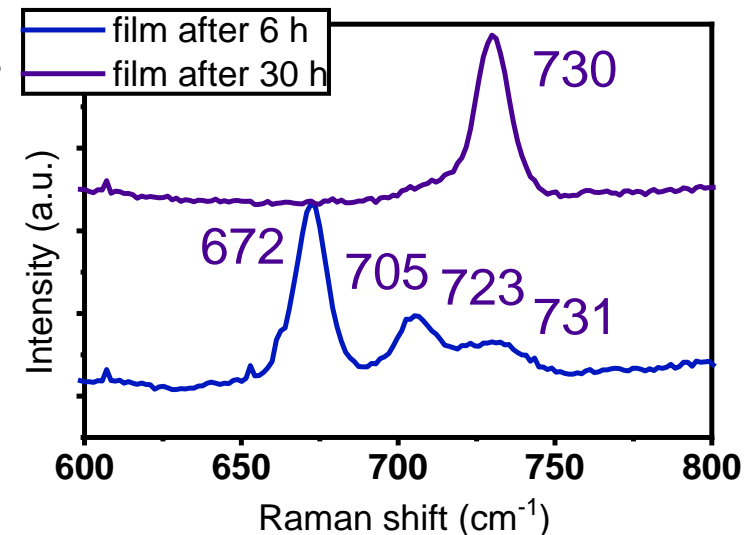
# Sol-gel evolution

Ink composition :  
 $\text{Cu}(\text{CH}_3\text{COO})\cdot\text{H}_2\text{O}$   
 $\text{Zn}(\text{CH}_3\text{COO})\cdot 2\text{H}_2\text{O}$   
 $\text{SnCl}_2\cdot 2\text{H}_2\text{O}$   
 in (DMSO and TU)

V. Trifiletti et al., Chemistry Select 2019, 4, (17), 4905



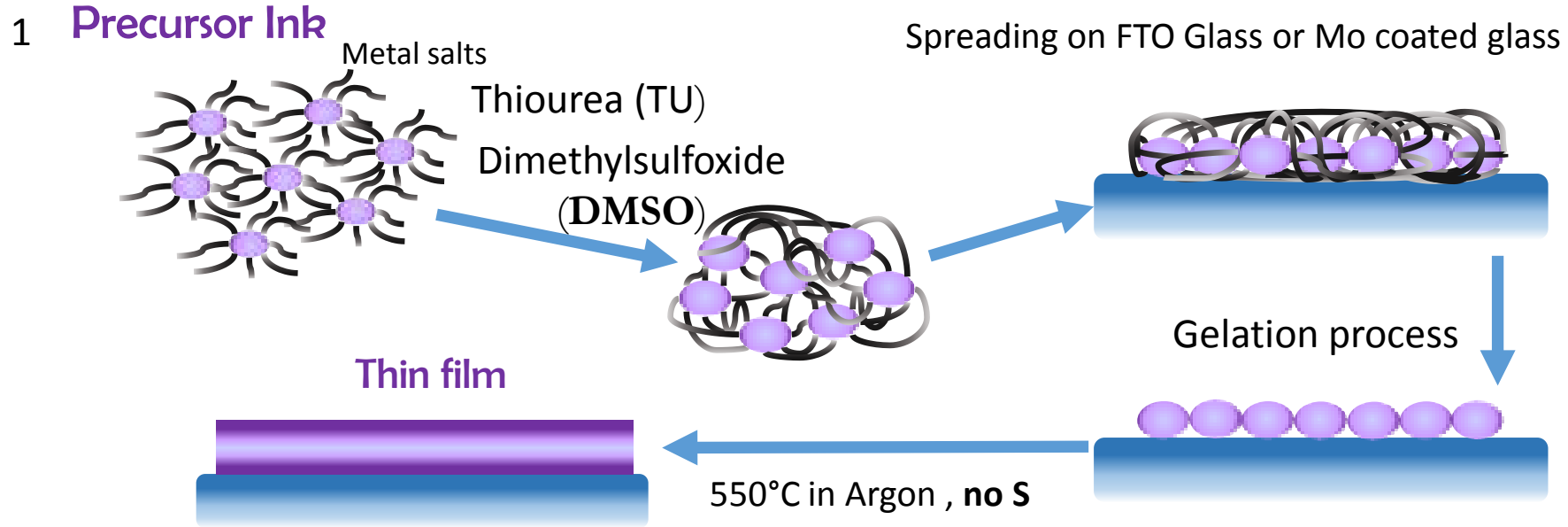
The Sol-gel viscosity increases due to polycondensation process, until the ink evolves to gel



After drying in air the DMSO signal disappears, and after 30 hours the thiourea signal splits in bands that are assigned to the metals coordinate by TU.

# Kesterite thin films by non toxic solution process

Several deposition methods



3 **Precursor-ink** + a ink jet printer (in progress)



$\text{Cu}(\text{CH}_3\text{COO})_2 \cdot \text{H}_2\text{O}$

0.8 mmol



$\text{Zn}(\text{CH}_3\text{COO})_2 \cdot 2\text{H}_2\text{O}$

0.5 mmol



$\text{SnCl}_2 \cdot 2\text{H}_2\text{O}$

0.5 mmol



Thiourea

9.0 mmol

Solvent:  
DMSO 3.0 mL



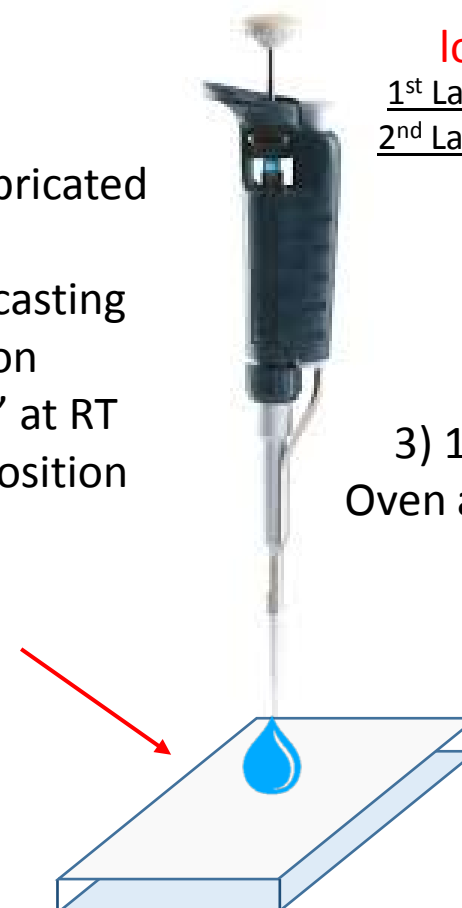
Thin films were fabricated  
by

- 1) a direct drop-casting  
of the solution
- 2) Gelation in 30' at RT  
after droplet deposition

**loading**

1<sup>st</sup> Layer: 4  $\mu\text{L}/\text{cm}^2$   
2<sup>nd</sup> Layer: 6  $\mu\text{L}/\text{cm}^2$

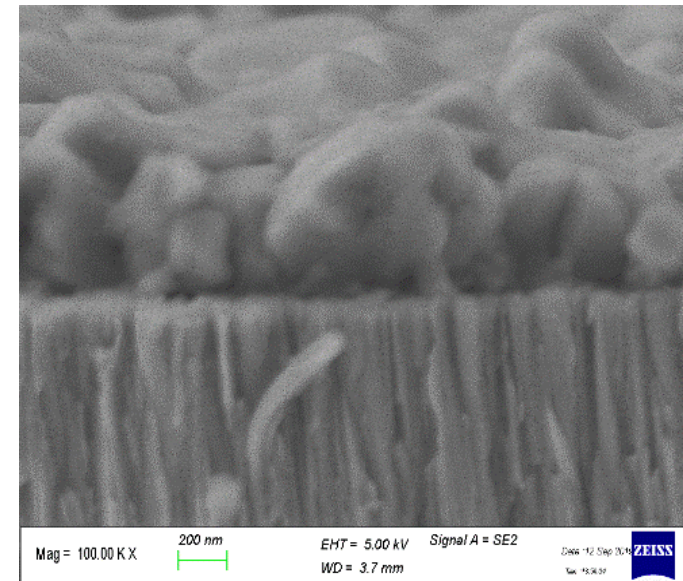
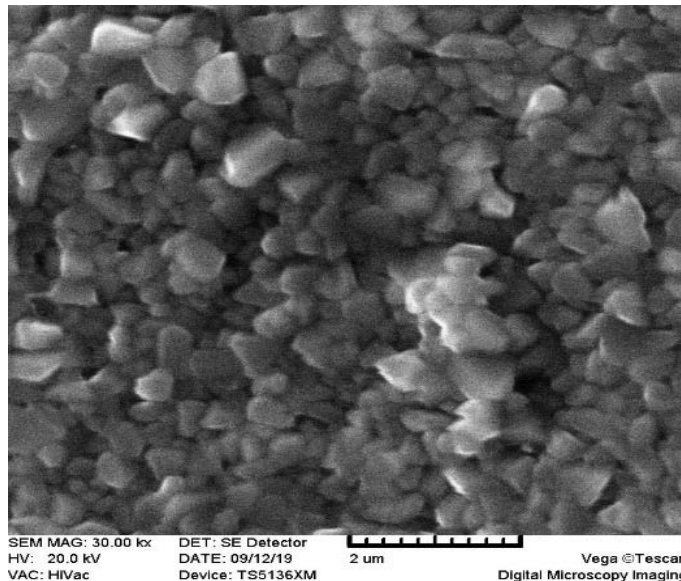
3) 1<sup>st</sup> and 2<sup>nd</sup> Layer:  
Oven annealing in Argon  
@ 550 °C



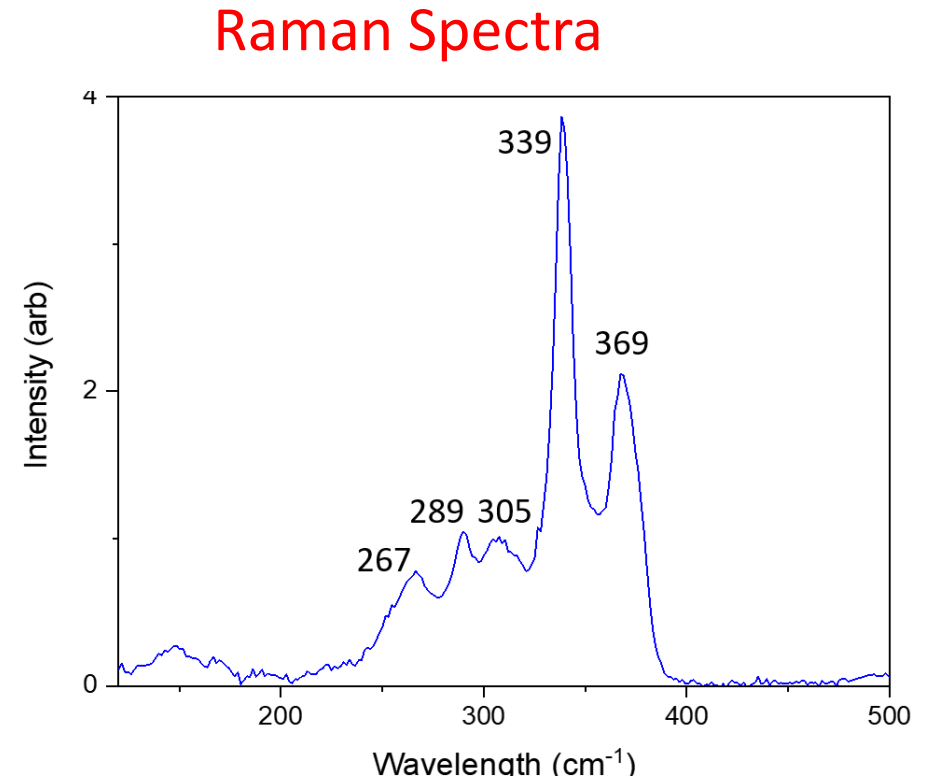
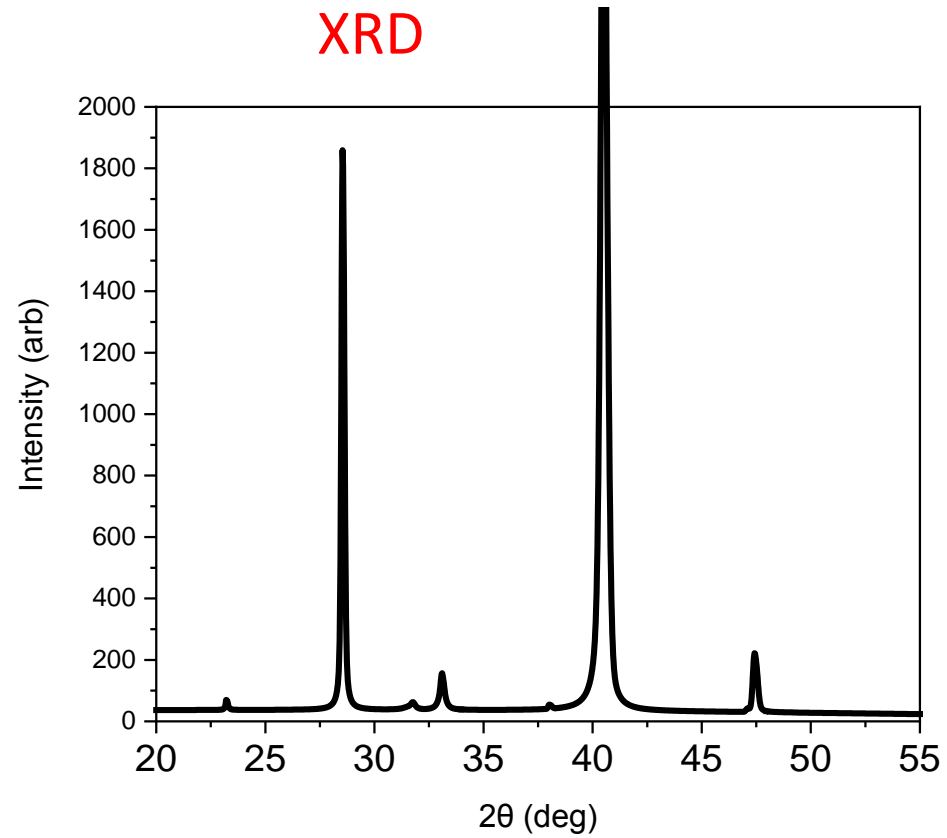
final thickness:  
1.2 -1.5  $\mu\text{m}$

# Optimization of the solution/film

Entry#	Cu/(Sn+Zn)	Zn/Sn	Thiourea [conc.]
1	1.00	1	3.7 M
2	0.91	1	3.7 M
3	0.86	1	3.0 M
4	0.83	1	3.0 M
5	0.80	1	3.0 M
6	0.80	1.1	3.0 M
7	0.80	1.2	3.0 M
8	0.80	1.2	2.3 M





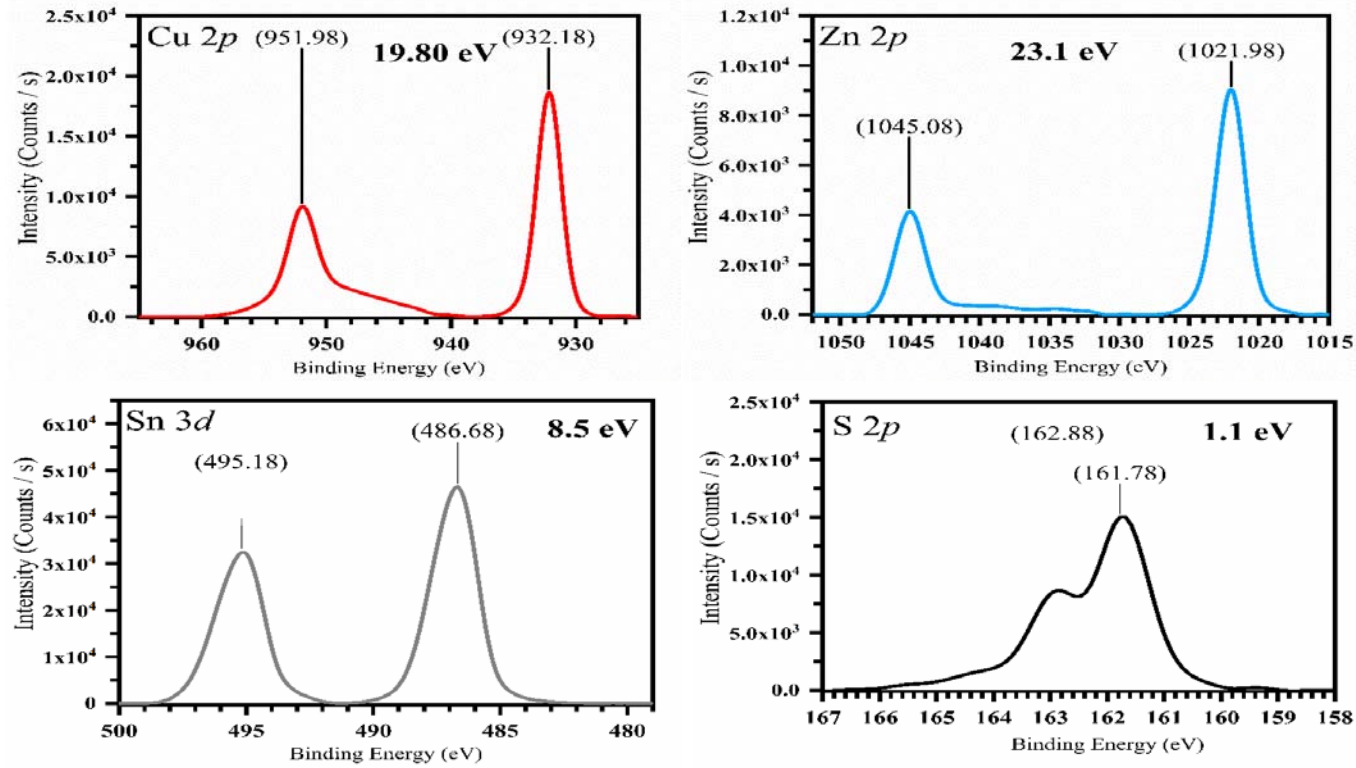


$2\theta = 16.5, 18.4, 23.3, 28.7, 33.2, 47.5$

Unpublished results

# XPS analysis on CZTS film

From Ms. Sally Luong, Dr Vanira Trifiletti and Dr Oliver Fenwick  
School of Engineering and Materials Science, Queen Mary University of London



Ion Beam Etch:  
30 sec x 3 times  
(30 nm each time)  
Energy 8000 eV  
Raster size 1 mm  
Cluster size 1000

Cu, Zn, Sn, and S oxidation states: Cu (I), Zn (II), Sn (IV) and S (II)

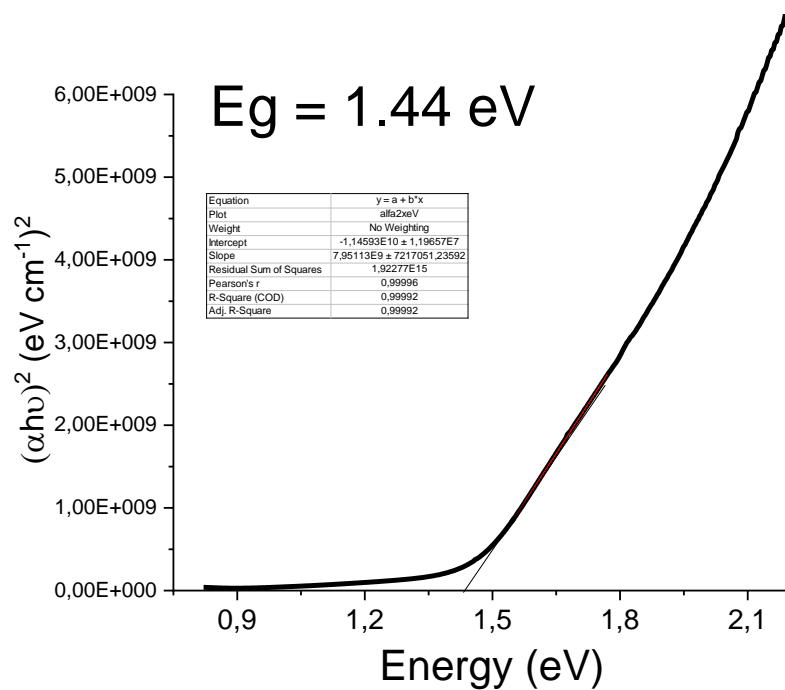
Sample #2

Unpublished results

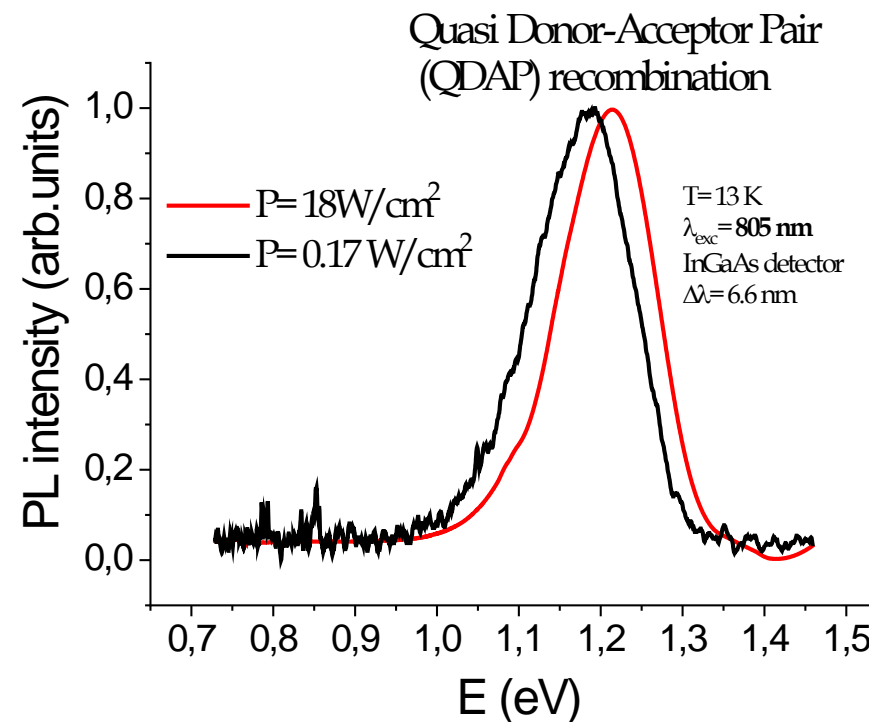
S.Binetti, Sydney 27th November 2019



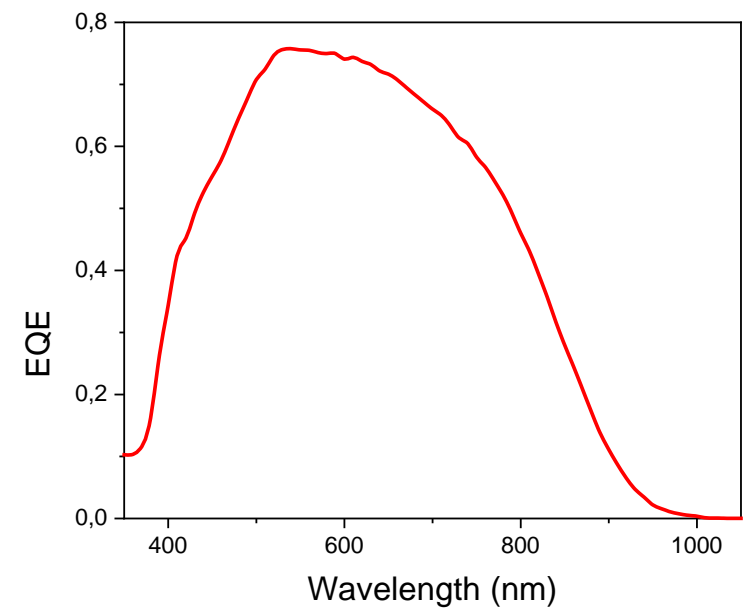
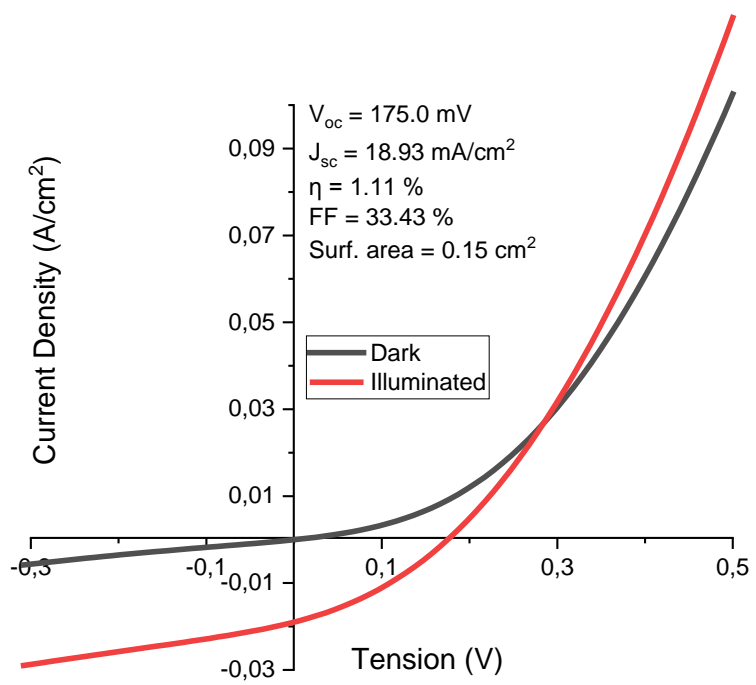
# Band gap and PL



Unpublished results



# Device Performance



$V_{oc} = 175.0 \text{ mV}$  → **Modest  $V_{oc}$**   
 $J_{sc} = 18.93 \text{ mA/cm}^2$  → **Respectable  $J_{sc}$**   
 $\eta = 1.11 \%$   
 $FF = 33.43 \%$

SCAPS software simulation indicates problems at the interface with the back contact

Unpublished results

# Tuning the gap



Molecular inks :

**CZFTS sol** was prepared by dissolving in DMSO:

- $\text{Cu}(\text{CH}_3\text{COO})_2 \cdot \text{H}_2\text{O}$ ;
- $\text{SnCl}_2 \cdot 2\text{H}_2\text{O}$ ;
- $\text{Zn}(\text{CH}_3\text{COO})_2 \cdot 2\text{H}_2\text{O}$ .
- $\text{Fe}(\text{CH}_3\text{COO})_2$

After complete dissolution, thiourea was added.

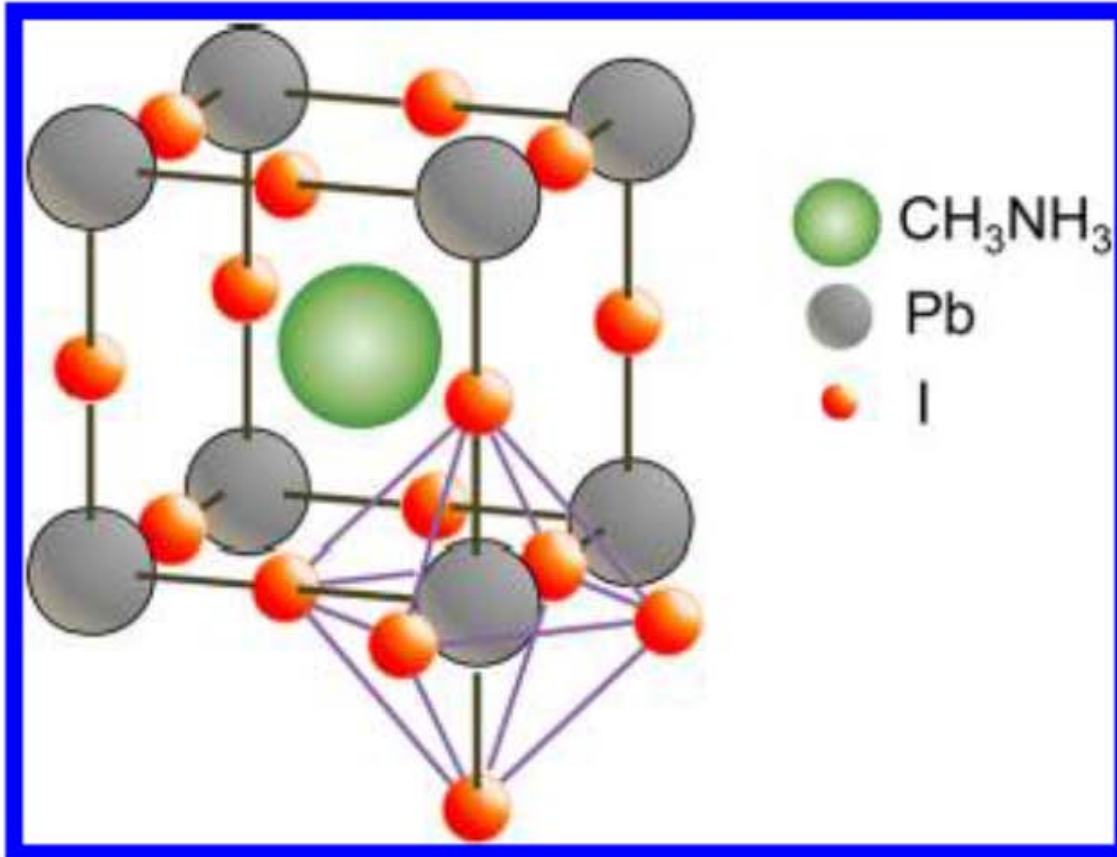


Ink is spread on Mo SLG and HT @550 °C in S  
Preliminary thin film results very promising



# Perovskite-based solar cells

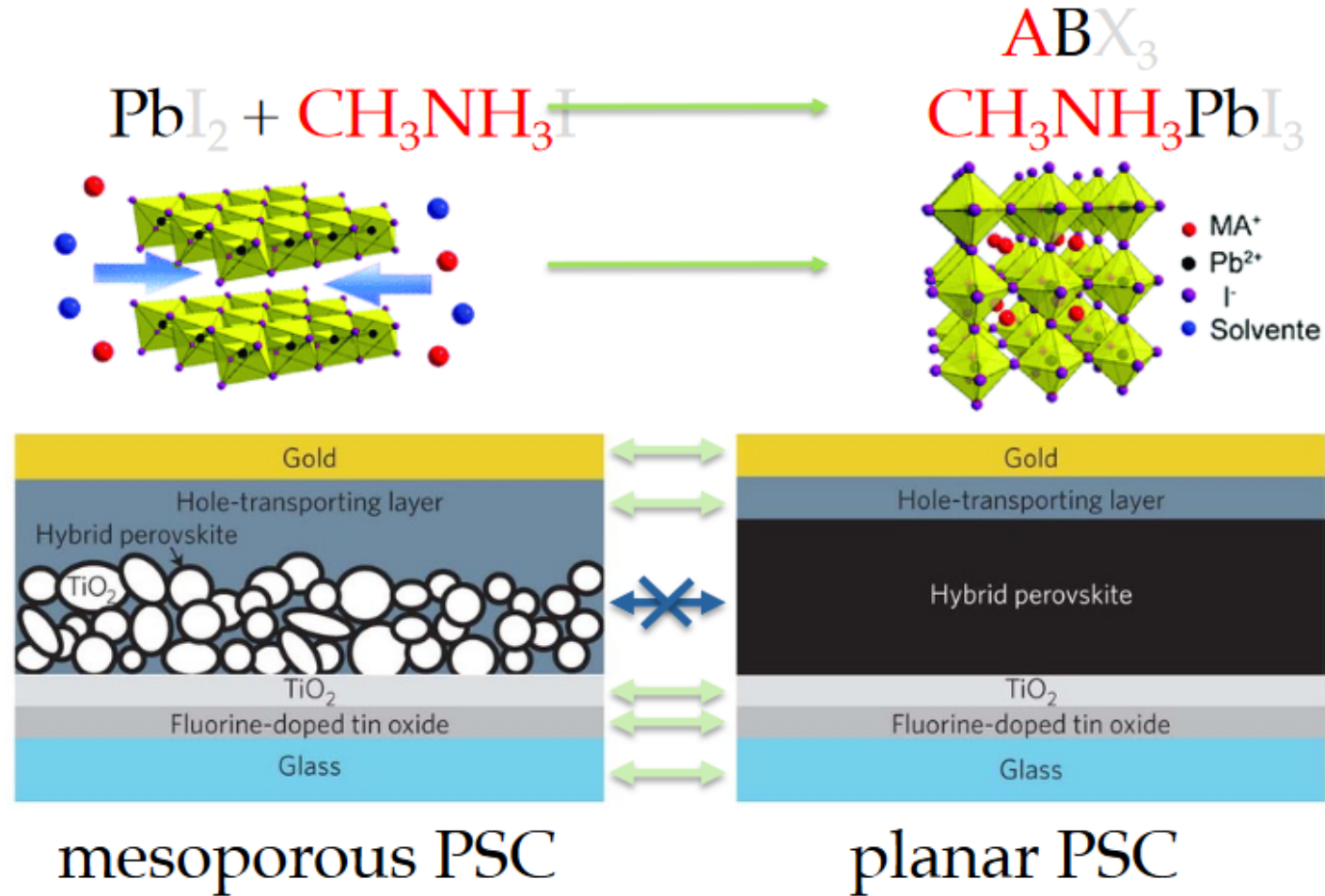
A new age for low cost high-efficiency PV



Park, N.-G. *J. Phys. Chem. Lett.* **2013**, 4, 2423 (perspective)

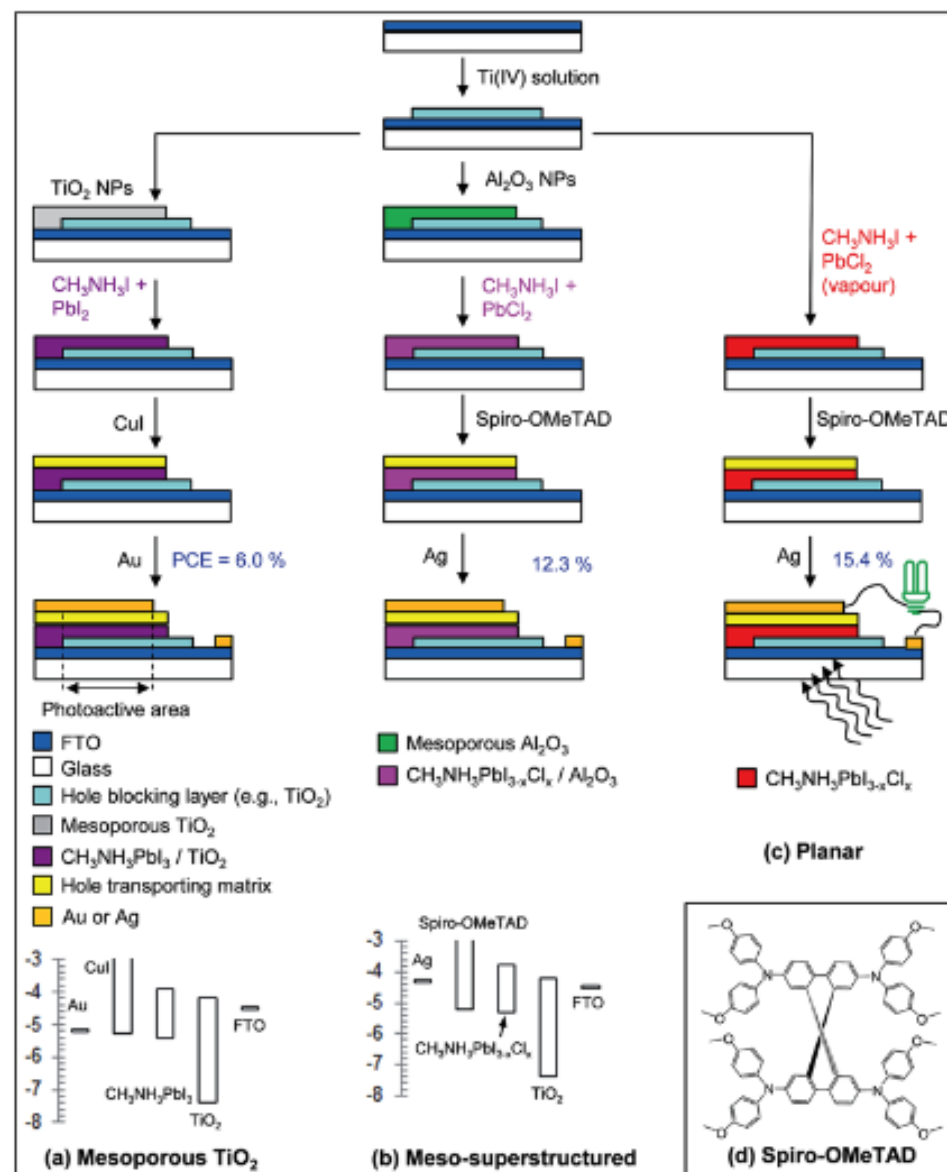
# Perovskite-based solar cells

A new age for low cost high-efficiency PV



# Perovskite-based solar cells: preparation

1. FTO cleaning
2. Hole blocking layer ( $\text{TiO}_2$  compact layer) (by spin coating or spray pyrolysis): 50-100 nm
3. Mesoporous  $\text{TiO}_2$  layer (by screen printing and sintering): 300-600 nm
4. Perovskite layer (one- or two-step sequence)
5. HTM layer (spiroOMeTAD or other HTM) (by spin coating)
6. Evaporation of photocathode metal contact (Au or Ag)
7. Encapsulation and measurement



# Perovskite-based solar cells

## PROS

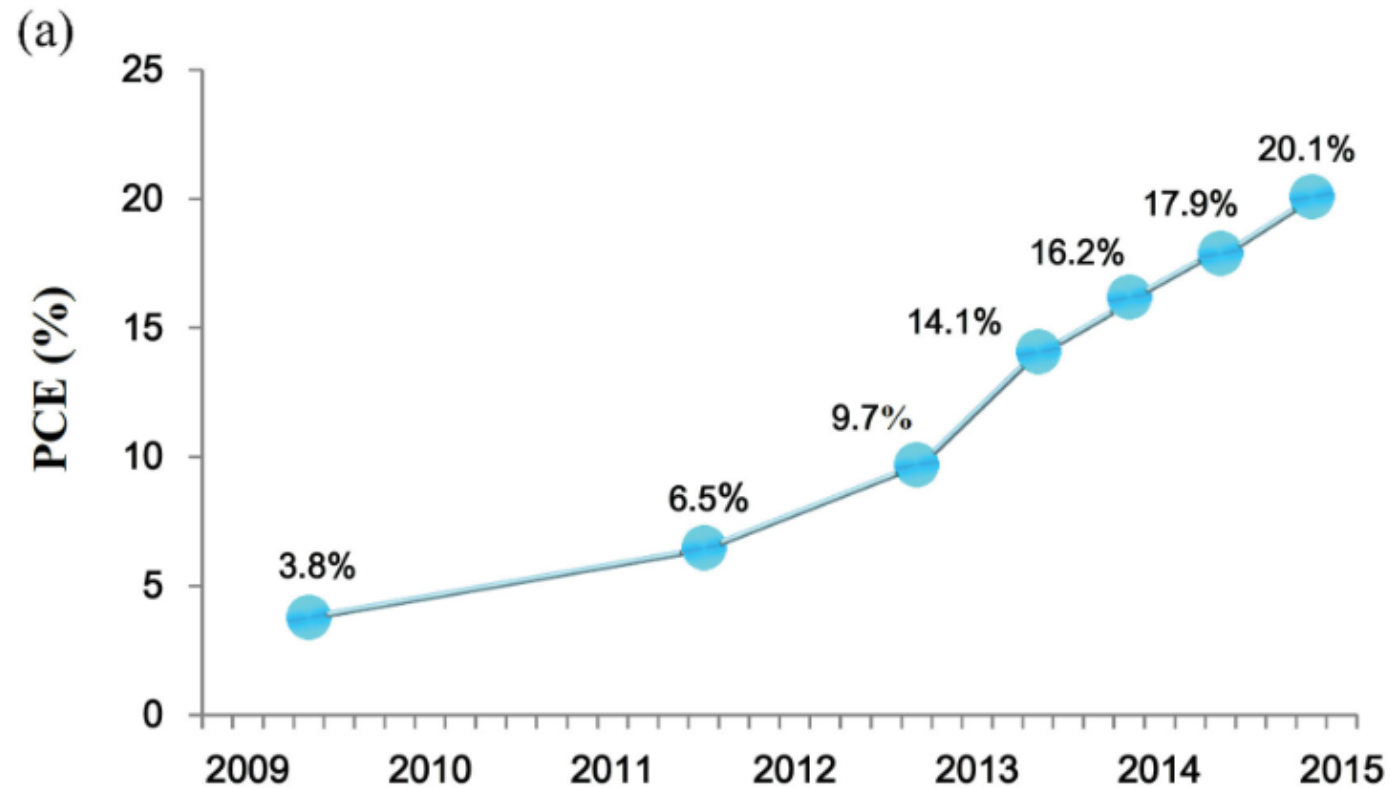
- strongly absorbing over a broad range ( $< 1 \mu\text{m}$  thin films)
- ideal for solid-state cells
- act as HTM and ETM as well
- lower loss-in potential and higher voltages (0.4 V)
- 20% efficiency reached
- extremely low cost

## CONS

- dissolve or decompose in the electrolyte (no liquid electrolytes)
- toxicity of Pb components
- full device stability in moisture and air to be proven
- degradation with UV light

# Perovskite-based solar cells

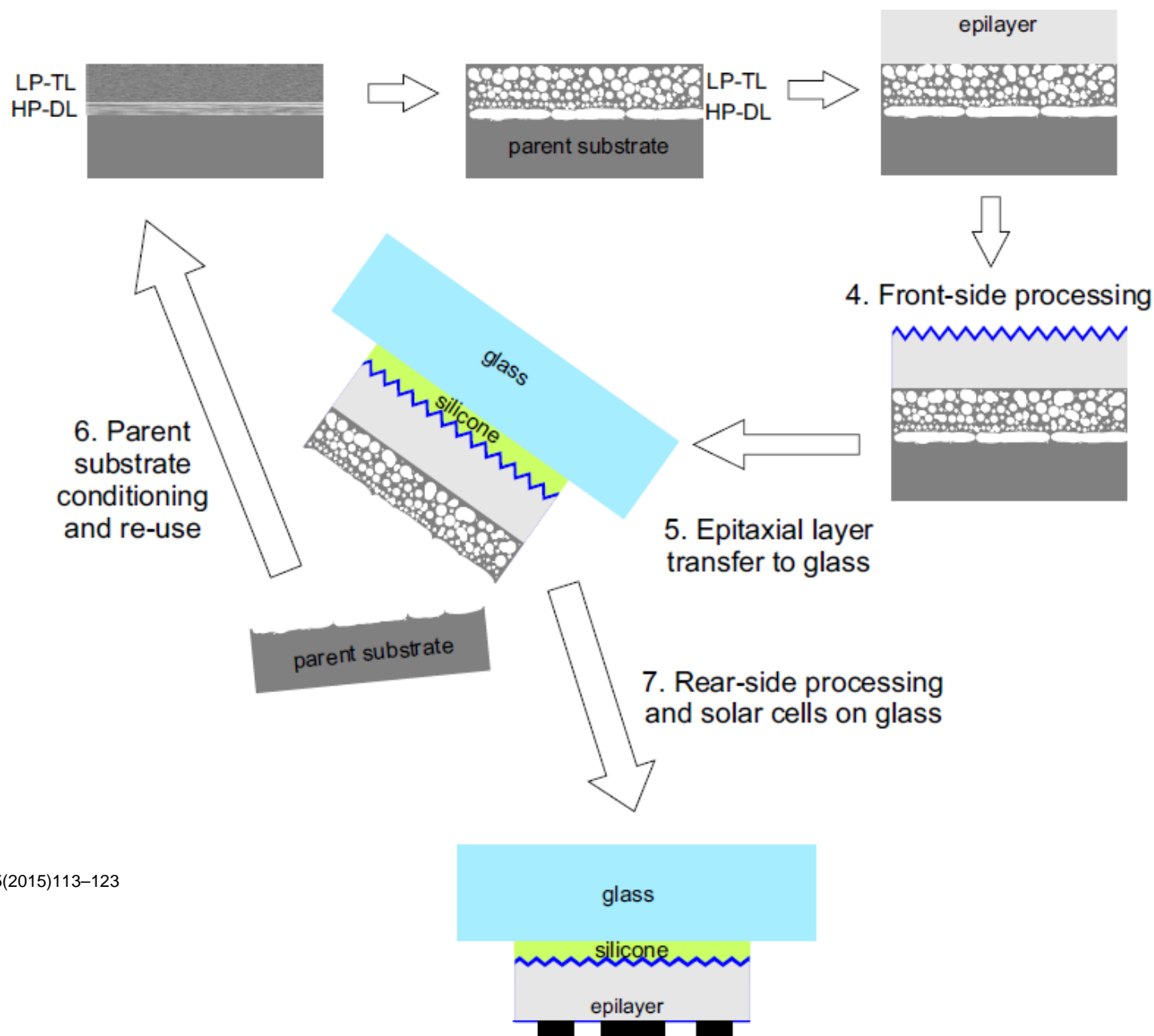
## World record efficiencies



- ✧ Last certified value: 20.1%
- ✧ World record (EPFL): 25.2%  
(2019)



# Addressing the challenge of automated handling of foils to high mechanical yield and throughput during cell fabrication



- Energy payback time for Si solar cells
- Northern Europe : 2, 5 years
- South 1, 5 years
- Pv system located in Sicily with mc-Si modules has an Energy pay back time of around 1 year !
- [www.ise-fraunhofer.de](http://www.ise-fraunhofer.de)

Assuming 30 year system life **Silicon** PV systems will provide a net gain of 28-29 years of pollution free and greenhouse gas free electrical generation

47

Ag

Silver  
107.868

it's a necessary component in photovoltaic solar cells in the form of paste used as a conductor.

In 2014 this sector accounted for 56% of overall demand for the silver.

The solar industry alone used at least 70 million ounces of silver in 2015.

- the average solar panel contains between 15 and 20 g of silver: (10 g /m<sup>2</sup>)
- solar could equal or exceed the silver volumes previously used in the photographic film industry

Rank ↕	Z ↕	Element ↕	Symbol ↕	Lithosphere abundance <sup>[1]</sup> ↕	Relative proportion (ppm) <sup>[2]</sup> ↕	Abundance in crust (ppm) <sup>[3]</sup> ↕	Abundance in crust (ppm) <sup>[4]</sup> ↕	Abundance in crust (ppm) <sup>[5]</sup> ↕	Production (2012, tonnes) <sup>[6]</sup> ↕
1	8	oxygen	O	460,000	474,000	460,000	467,100	461,000	
2	14	silicon <sup>[A]</sup>	Si	277,200	277,100	270,000	276,900	282,000	7,600,000

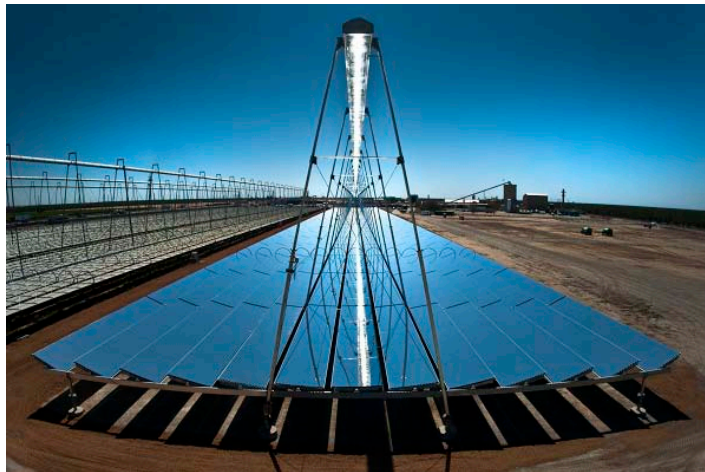
65	47	silver	Ag		0.070	0.080		0.075	24,000
66	80	mercury	Hg		0.05	0.067		0.085	1,600
67	34	selenium	Se		0.05	0.05		0.05	2,000

# Silver and other PV technologies

- Concentrated solar power CSP : systems of mirrors or lenses that concentrate solar light into a small device
- Silver is essential for this technology, since due to its superior light reflectivity characteristics it is the first choice of material for such mirrors.

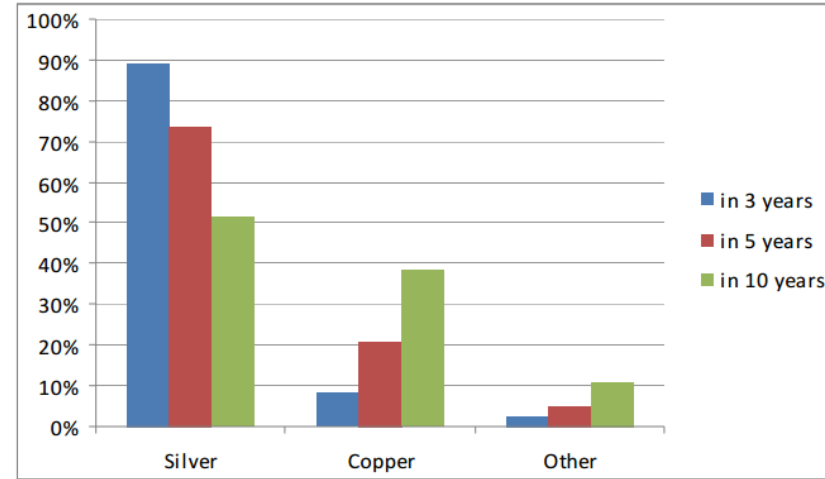
## Silver requirement for the various concentrated solar power technologies\*

	Silver content [kg/m <sup>2</sup> ]	kg/MW
Fresnel reflector	0.001	13.75
Parabolic trough	0.001	3.75
Solar power tower	0.001	7.57



# Silver's matter

The cumulative PV capacity aimed for 2050 exceeds known silver reserves



Considering also for CSP capacities by region in 2030 and 2050 forecast

GW	United States	Other OECD Americas	European Union	Other OECD	China	India	Africa	Middle East	Other developing Asia	Non-OECD Americas	World
2013	1.3	0.01	2.31	0.01	0.02	0.06	0.06	0.10	0.02	0	4.1
2030	87	6	15	4	29	34	32	52	0.3	2	261
2040	174	18	23	12	88	103	106	131	3	7	664
2050	229	28	28	19	118	186	147	204	9	15	982

\*The International Energy Agency (IEA) Roadmap 2014

## Solution

1. reduce the use of Ag (the target is up to 0.82 g/m<sup>2</sup> )
2. Silver replacement
3. Develop other PV technologies that do not contain any silver



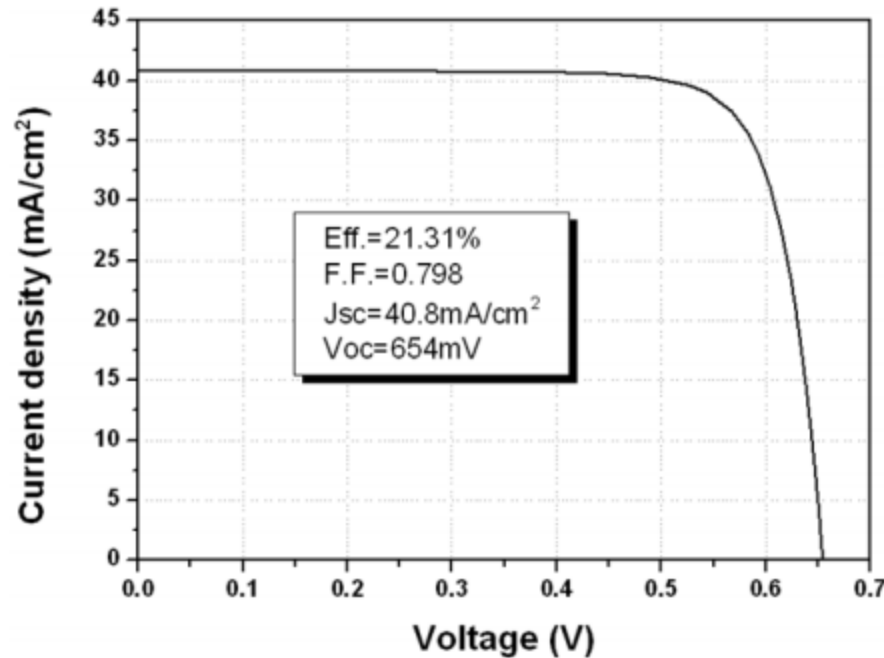
# Silver Replacement

- Two metals were chosen as alternative contacting material: nickel and zinc.  
Ni is cheap and can make a good contact to Si by means of Ni silicides
  - higher specific electrical resistivity than silver: Ni =  $8.7 \Omega \text{ cm}$  and Zn =  $6.1 \Omega \text{ cm}$  as compared to Ag =  $1.6 \Omega \text{ cm}$ , which makes it necessary to increase the line conductivity of the fingers in a second printing step for example by Cu paste.

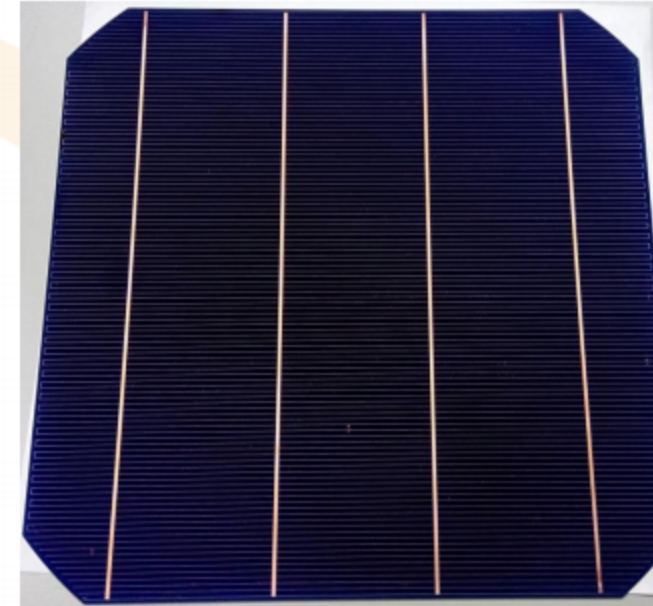
Ni/Cu plating : advantages ;  
Stable , low cost , high conductivity



# >21% Cell Efficiency



Data corrected			
Cell Type:		nPERT	
Serial Number:		0225479	
Reference:		reference	
Cell Area:	[cm <sup>2</sup> ]	238.95	
E	STC	[W/m <sup>2</sup> ]	1000
Temp	STC	[°C]	25.00
E	meas.	[W/m <sup>2</sup> ]	944
Temp	meas.	[°C]	26.66
Uoc	[V]		0.654
Isc	[A]		9.748
Ump	[V]		0.557
Imp	[A]		9.135
Pmax	[W]		5.092
FF	[%]		79.82
N	[%]		21.31
Rs	[mOhm]		2.07
Rsh	[Ohm]		119
Iap	[A] at 0.50V		9.577
Irev1	[A] at -10.00V		0.847
Irev2	[A] at -12.00V		1.407



I-V curve of Motech plated n-PERT solar cell

n-PERT (Passivated Emitter, Rear Totally Diffused)

Best cell efficiency with different metallization

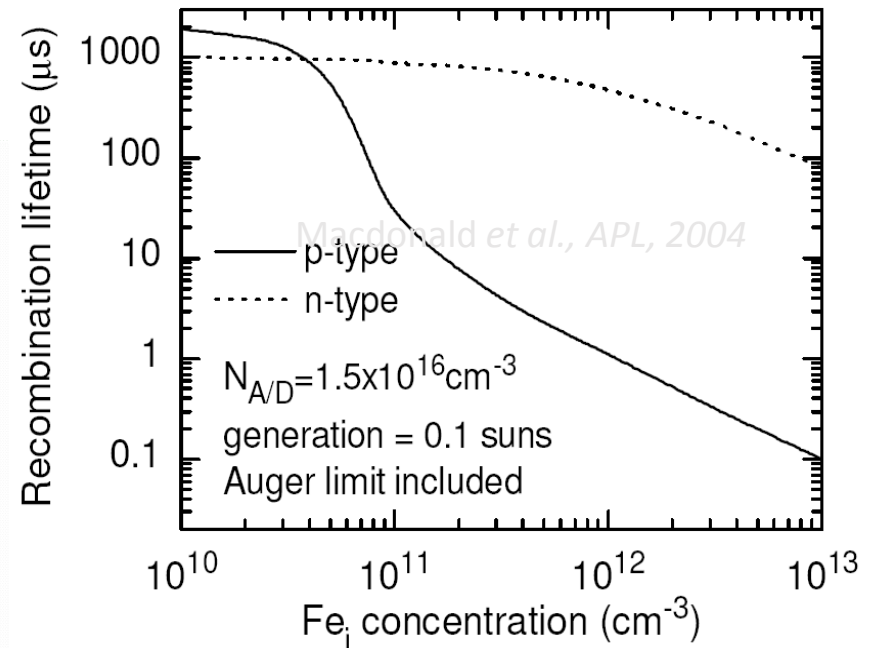
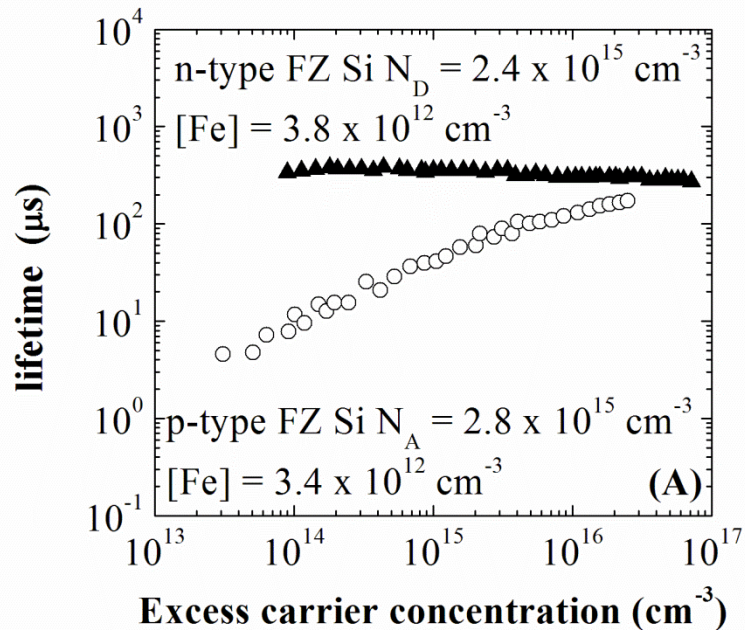
Conditions	Eff. (%)	FF	Voc (mV)	Jsc (mA/cm <sup>2</sup> )
Ag/Al paste	20.90	0.801	655	39.84
Ni/Cu/Sn	21.31	0.798	654	40.80

# n-type silicon

- No Boron

- Most impurities in silicon as Fe capture electrons easier than holes.

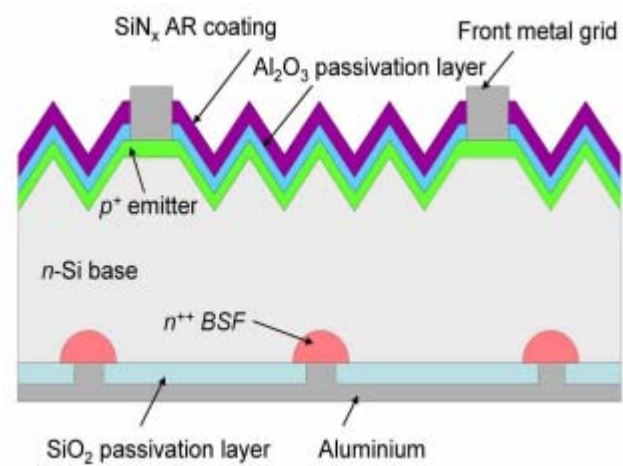
- Minority carriers specie in p-type silicon: electrons 😞
- in **n-type** silicon: holes 😊



Source: Francesca Ferrazza ENI

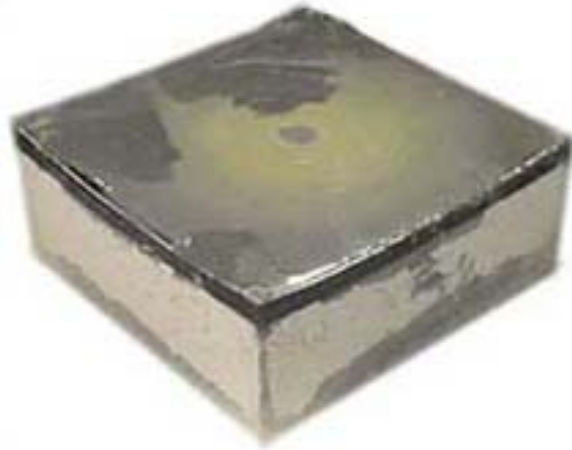
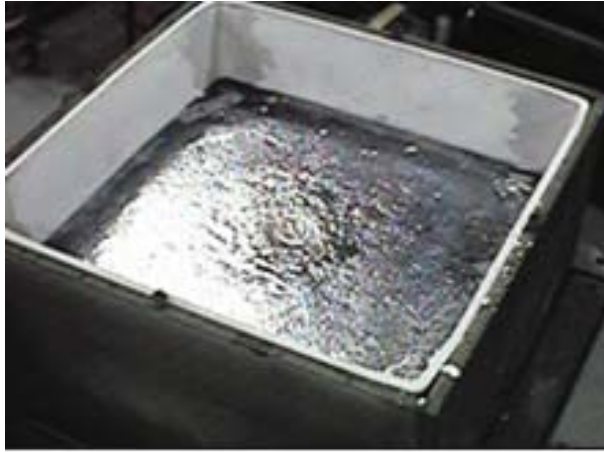
In n-type Fe is less active as recombination center

## n-type cell back

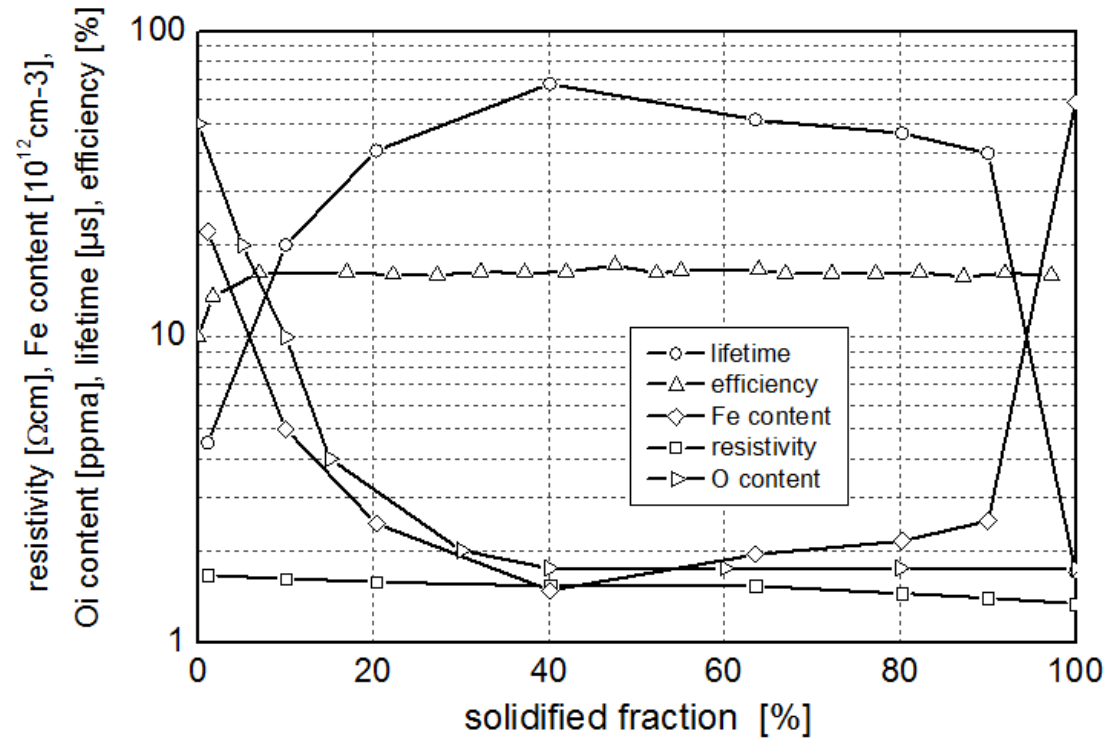


In summary, an exceptionally high conversion efficiency of 23.2% for an n-type PERC solar cell with a front side B-doped emitter has been reported. The highest reported efficiencies on n-type material were 22.7% 681 mV on a backside-contact solar cell , 22.7% 702 mV on a rear emitter PERT solar cell.<sup>23 T</sup>

# Effect of impurities on lifetime



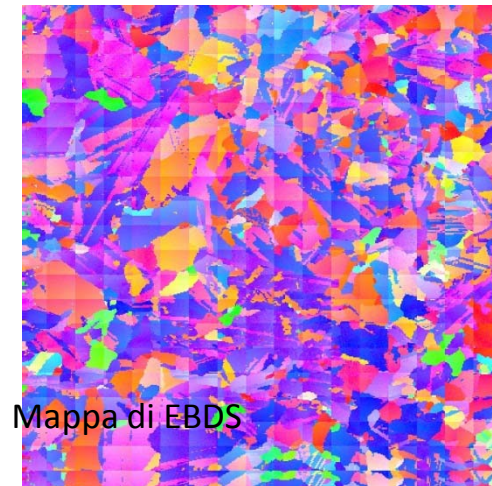
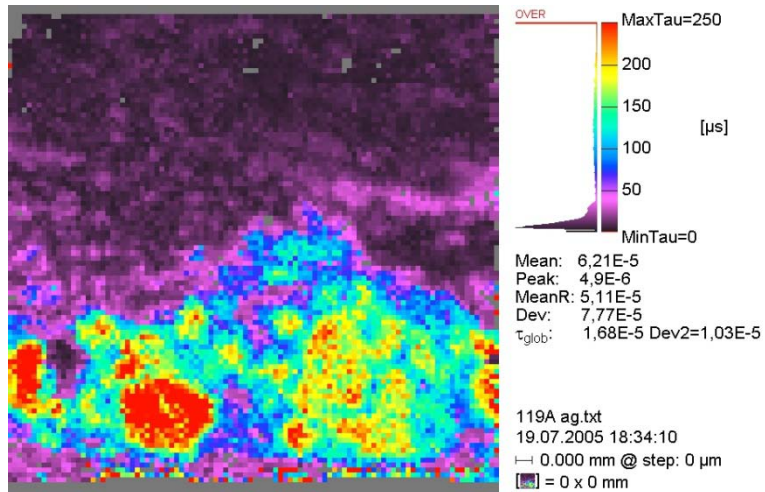
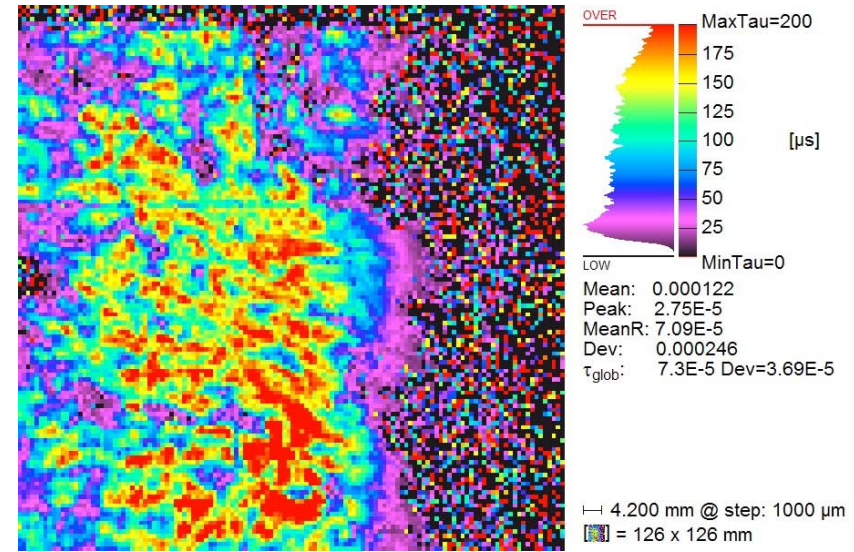
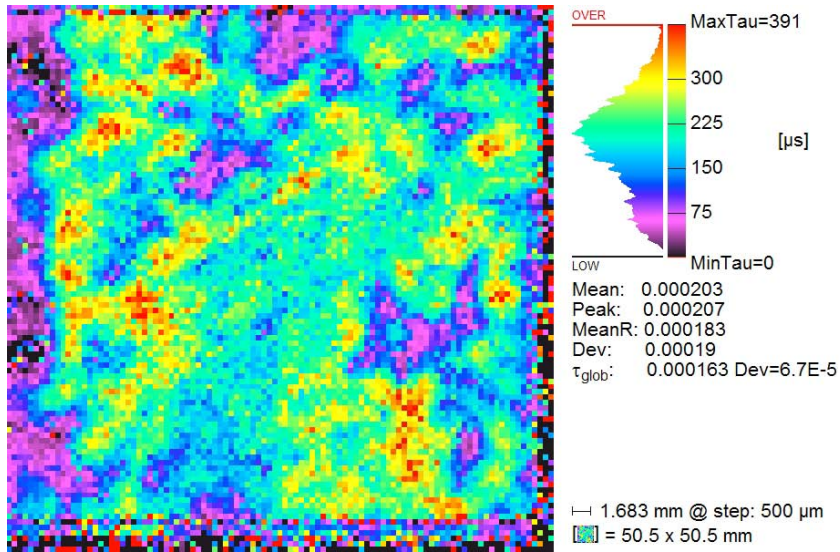
## Iron





# Effetto impurezze e difetti su proprietà elettriche : lifetime ( $\tau$ ) mappe di tempo di vita ( $\tau$ )

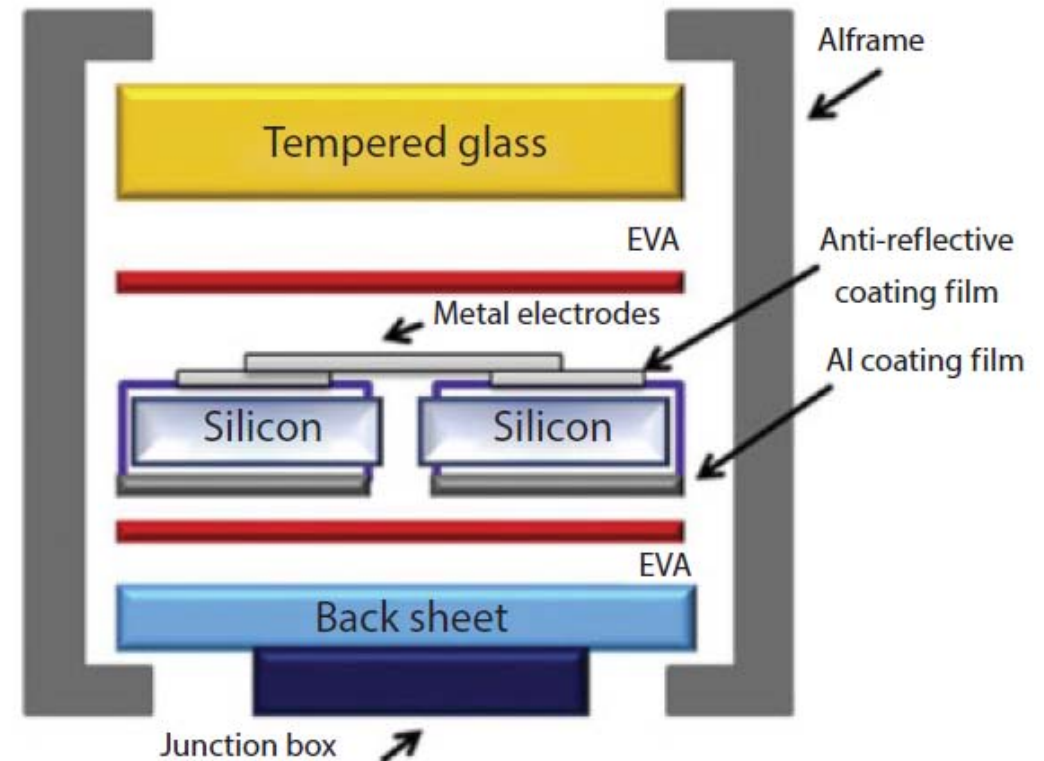
120x120 mm



# Recycling process

The amount of waste PV panel is estimated to reach 9.57 million tonnes in 2050 \*

Material	Cryst. Si
glass	60 – 85%
aluminium	10 – 20 %, 0%
polymers	7 – 10%
interconnectors	Cu, solder coated ca. 1%
Solar Cells	ca. 3 %



PV CYCLE achieves 96% recycling rate for silicon based PV modules

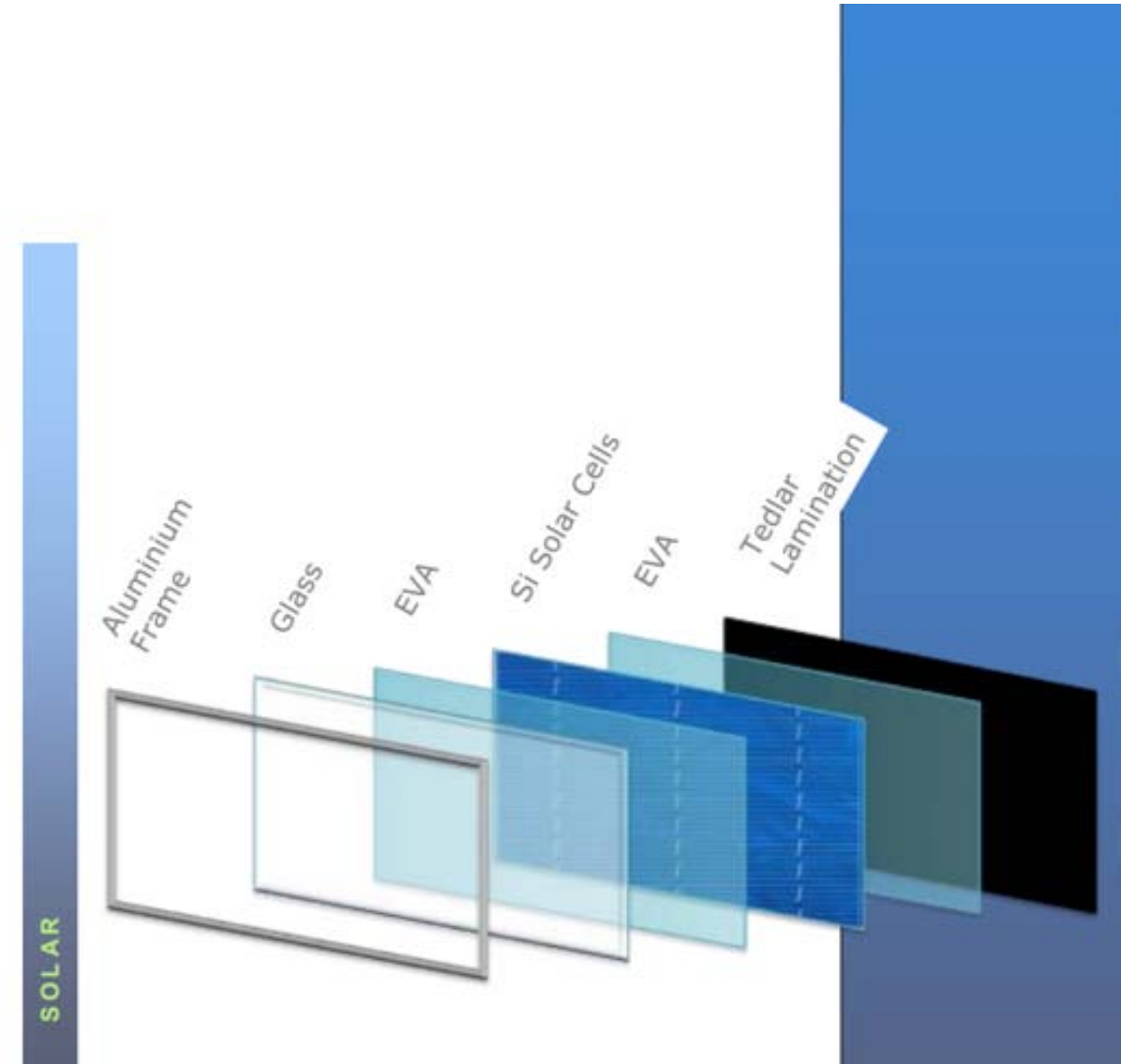
\*Bio Intelligence Service (BioIS), Study on photovoltaic panels supplementing the impact assessment for a recast of the WEEE directive – Final report, 2011

## Busbar Copper coated with a tin-lead alloys

Metal	Weight (%)
Copper	83
Lead	7
Tin	10

Average material distribution of a c-Si cell.

Material	Weight %	Deviation ( $\pm 2\sigma$ )
Silicon	96.74	$\pm 0.38$
Silver	1.26	$\pm 0.02$
Aluminum	1.12	$\pm 0.21$
Copper	0.94	$\pm 0.03$
Chromium	0.14	$\pm 0.01$
Lead	0.10	$\pm 0.01$





# Challenge and opportunity of PV waste



A growing wave of PV wastes is expected globally, starting in Europe where PV was first installed. PV waste recycling is legally regulated only in the EU.



Economic solutions for a high-value recycling of all valuable materials are urgently needed.

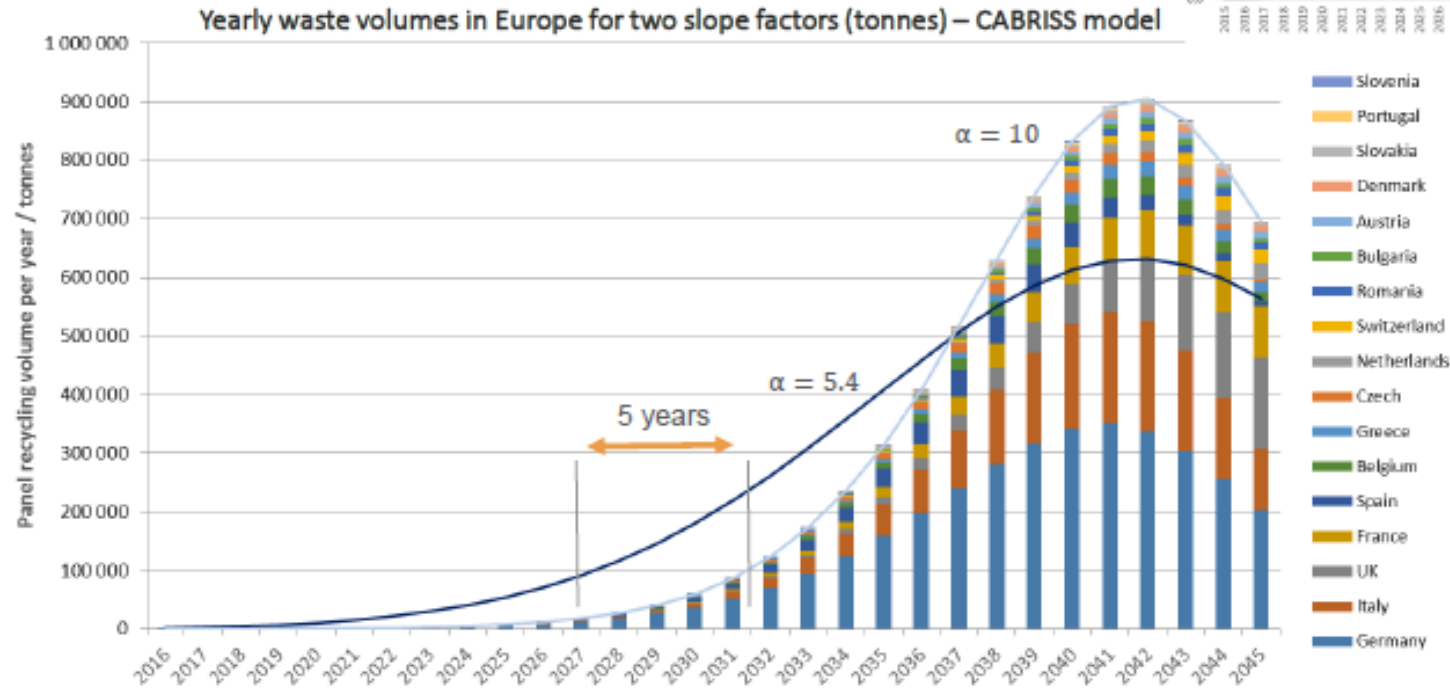
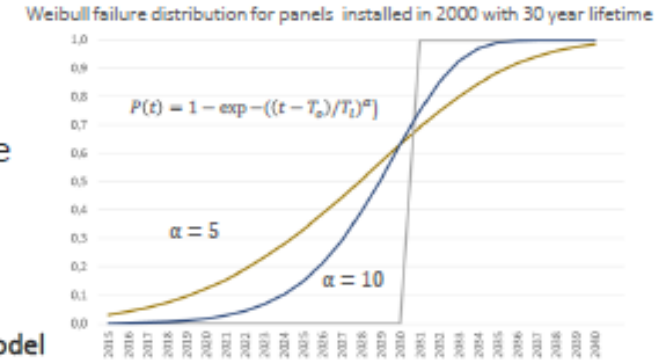


Up to now, PV manufacturers are not systematically using recycled materials.



# End-of-life panel waste volumes

- The modeling shows that the peak of European end of life waste will occur in 2042 (~ independent of the slope factor)
- The slope factor changes substantially the onset of panel waste
- For example, the date estimated for 100 000 tonnes of annual waste changes by 5 years according to common slope factors



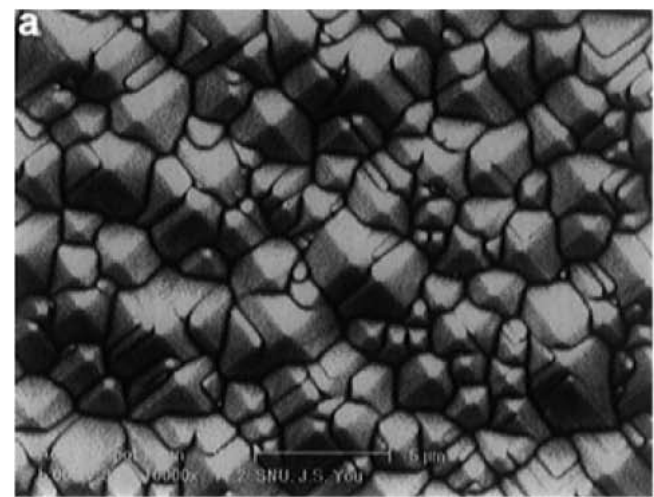
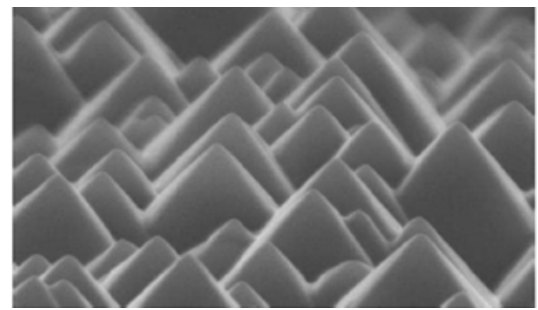
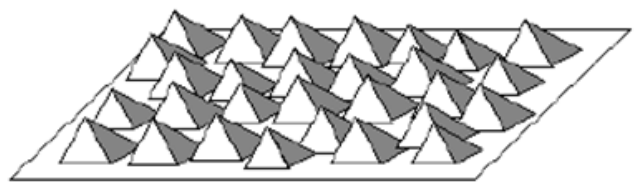




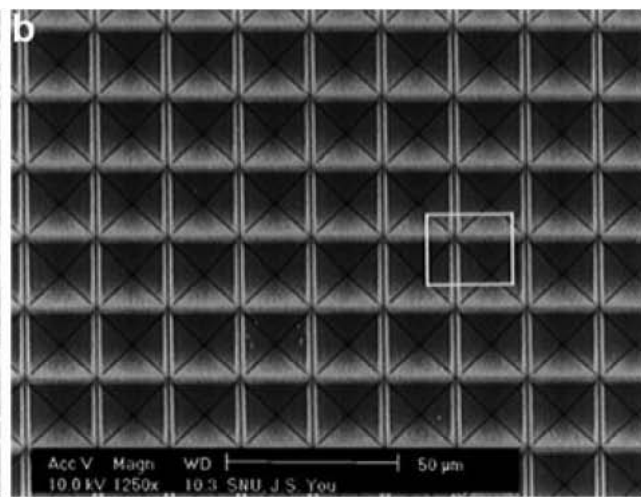
# Texturization process



- Reduces the reflection
- increase the optical path : a solar cell with no light trapping features may have an optical path length of one device thickness, while a solar cell with good light trapping may have an optical path length of 50, indicating that light bounces back and forth within the cell many times.



Random distributed pyramids :  
 Mono Si : KOH or NaOH-based : 5% 80°C , 15'  
 Poly : HNO<sub>3</sub> + HF



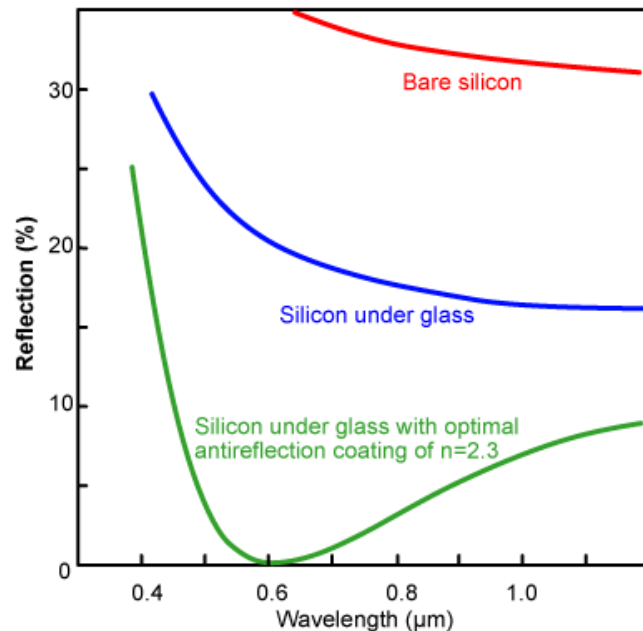
Uniform inverted pyramids:  
 Etching mask on (100) Si (+ I<sub>sc</sub>=1 mA /cm<sup>2</sup>)

# Anti-reflection and passivation layer

- The loss by reflection must be reduced
- The surface recombination of photogenerated carriers must be minimized

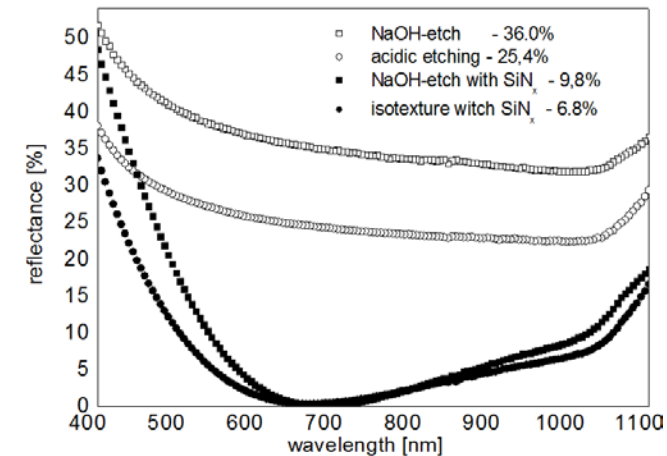
PECVD deposition of  $\text{SiN}_x$  :

In order to reach the deep blue colour and thereby minimise the reflectance, a layer thickness of ca. 70 nm is deposited. The dielectric layer has additional benefits for the solar cell. As the layer is hydrogen (H) rich, the surface and the bulk is passivated by H, as it attaches to Si dangling bonds.

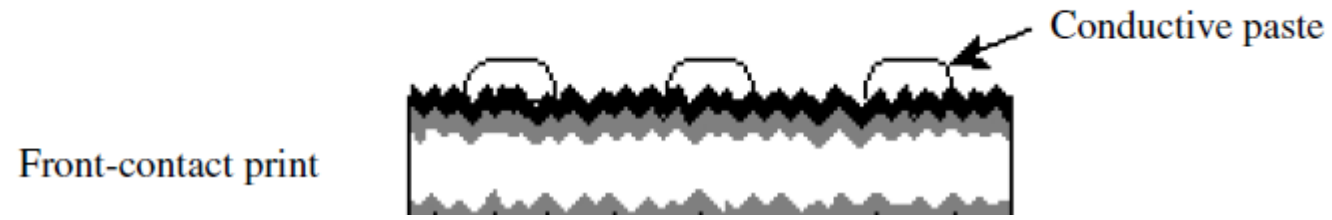


$x = 70 \text{ nm}$

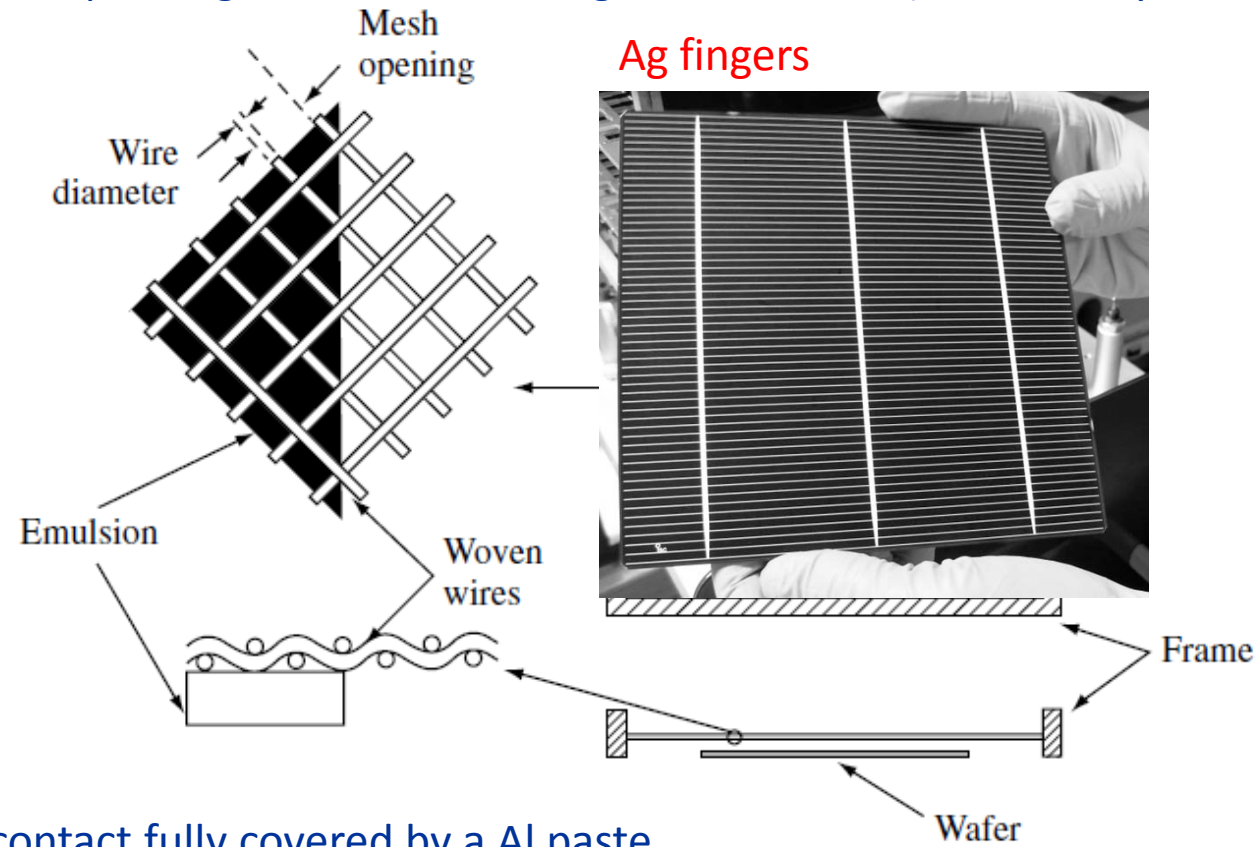
Color blue



# Contacts



Front contact : screen printing method + annealing @ 100-200 °C (most widely used)



Rear contact fully covered by a Al paste

47

Ag

Silver  
107.868

it's a necessary component in photovoltaic solar cells in the form of paste used as a conductor.

In 2014 this sector accounted for 56% of overall demand for the silver.

The solar industry alone used at least 70 million ounces of silver in 2015.

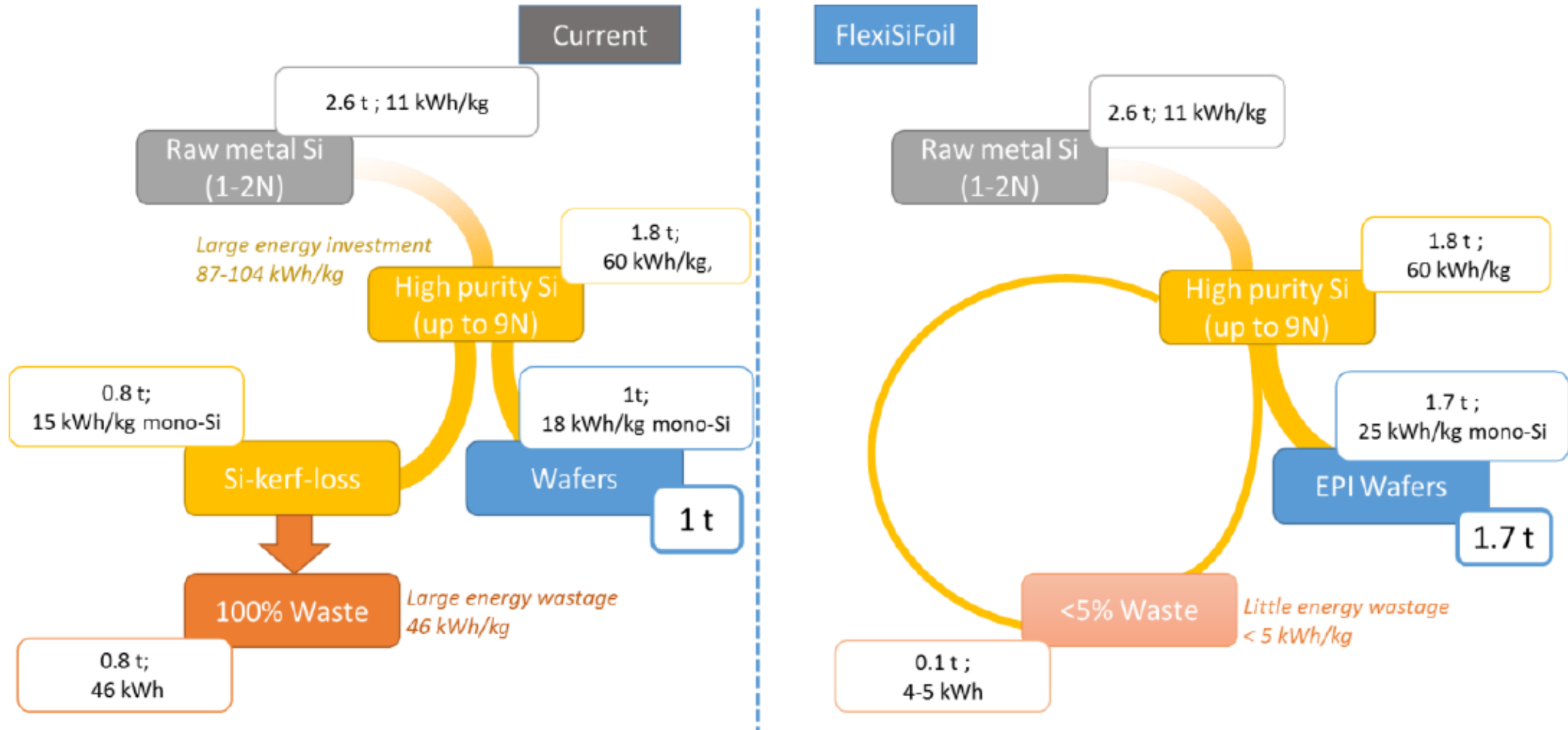
- the average solar panel contains between 15 and 20 g of silver: (10 g /m<sup>2</sup>)
- solar could equal or exceed the silver volumes previously used in the photographic film industry

Rank ↕	Z ↕	Element ↕	Symbol ↕	Lithosphere abundance <sup>[1]</sup> ↕	Relative proportion (ppm) <sup>[2]</sup> ↕	Abundance in crust (ppm) <sup>[3]</sup> ↕	Abundance in crust (ppm) <sup>[4]</sup> ↕	Abundance in crust (ppm) <sup>[5]</sup> ↕	Production (2012, tonnes) <sup>[6]</sup> ↕
1	8	oxygen	O	460,000	474,000	460,000	467,100	461,000	
2	14	silicon <sup>[A]</sup>	Si	277,200	277,100	270,000	276,900	282,000	7,600,000

65	47	silver	Ag		0.070	0.080		0.075	24,000
66	80	mercury	Hg		0.05	0.067		0.085	1,600
67	34	selenium	Se		0.05	0.05		0.05	2,000

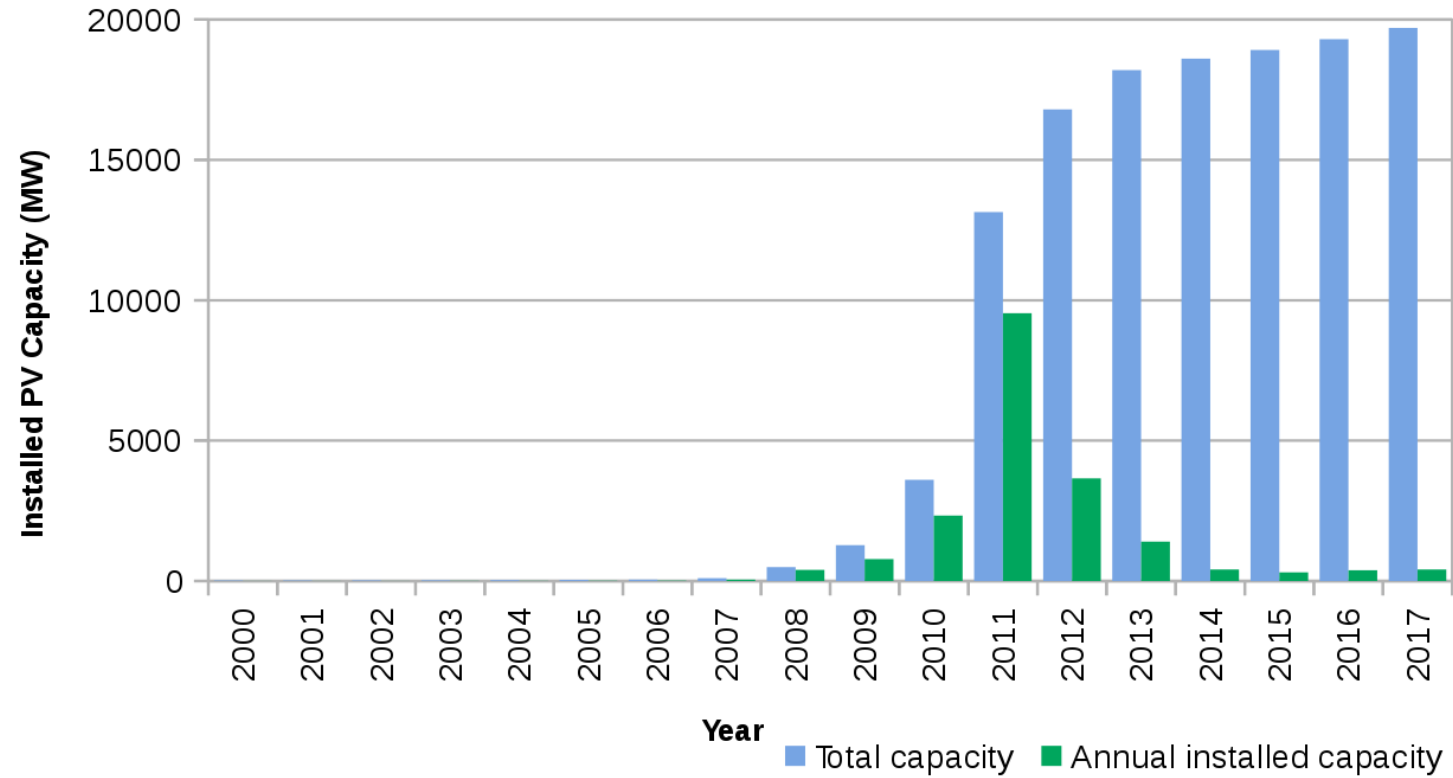
L.Grandel, A. Thorenz Renewable Energy 69 (2014) 157 -166

**Estimated energy and material consumption for the Epi-Foil process, compared with current state of the art mono-Si wafer manufacturing process. For the current state-of-art 2.6 t raw metal Si/1.8 t poly-Si is required to produce 1 t of mono-Si wafers.**





Annual and total installed PV capacity  
in Italy during the 21st century



## Key role of PV forecasts in all major future energy scenarios

Based on current market trends it has been estimated that :

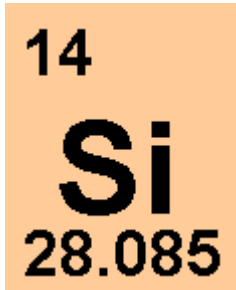
- PV has the potential to meet 15 % EU electricity demand in 2030
- PV can give considerable contribution to the reduction of CO<sub>2</sub> emissions, since the carbon footprint of PV systems is up to 65 times lower than that of fossil fuel-based electricity, with no CO<sub>2</sub> emissions during operations

4 600 GW of installed PV capacity by 2050 would avoid the emission of up to 4 gigatonnes (Gt) of CO<sub>2</sub> annually



The COP21's overarching goal from Paris to reduce greenhouse gas emissions and to limit the global temperature increase clearly showed that expectations for PV are high, confirmed by COP25

# Availability



Silicon constitutes about 26% of the Earth's crust and it is the second most abundant element in weight

Most of the earths' crust is made up of silica and miscellaneous silicates associated with aluminium, magnesium and other elements

Production of silicon : In 2006 the silicon demand for solar surpassed for the first time that for electronics, and now more than 80% of the 100,000 tons produced by the industry were dedicated to the PV market .